

有关敝司产品的注意事项

请务必在使用敝司产品之前阅读。

注意

■ 本产品目录所记载的内容为2016年10月之内容。因改良等原因，可能会不经预告而变更记载内容，所以请务必在使用前先确认最新的产品信息。未按照本产品目录所记载的内容或交货规格说明书使用敝司产品的，即便其致使使用设备发生损害、瑕疵等时，敝司也不承担任何责任，敬请悉知。

■ 就规格相关的详细内容，敝司备有交货规格说明书，详情请向敝司咨询。

■ 使用敝司产品时，请务必事先安装到设备之后，在实际使用的环境下进行评估和确认。

■ 本产品目录中所记载的产品可使用于一般电子设备 [音像设备、办公自动化设备、家电产品、办公设备、信息/通讯设备 (手机、电脑等)]。因此，若考虑将本产品目录所记载的产品使用于可能会直接危及生命或身体的设备 [运输用设备 (汽车驱动控制设备、火车控制设备、船舶控制设备等)、交通信号设备、防灾设备、医疗用器械、高公共性信息通信设备 (电话交换机以及电话、无线、广播电视等基站)] 等时，请务必事先向敝司咨询。

另外，请勿将敝司产品使用于对安全性和可靠性要求较高的设备 (航天设备、航空设备、原子能控制设备、海底设备、军事设备等)。

且即便属于一般电子设备，使用于对安全性和可靠性要求较高的设备、电路上时，敝司建议进行充分的安全评估，并根据需要，在设计时追加保护电路等。

未经敝司的事先书面同意，把本产品目录中记载的产品使用于前述需要向敝司咨询的设备或敝司禁止使用的设备，从而给客户或第三方造成的损害的，敝司不承担任何责任，敬请悉知。

■ 因使用敝司产品，发生第三方的知识产权等权利相关问题的，敝司不承担责任。另外，并不代表授予这些权利的实施权，敬请悉知。

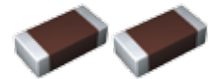
■ 除非书面合同中另有规定，敝司产品的保证范围仅限于交付的敝司产品单品，并且就敝司产品的故障或瑕疵所导致的损害，敝司不承担任何责任，敬请悉知。

■ 本产品目录所记载的内容适用于从敝司营业所、销售子公司、销售代理店 (即“正规销售渠道”) 购买的敝司产品，并不适用于从上述以外的渠道购买的敝司产品，敬请悉知。

出口相关注意事项

本产品目录所记载的部分产品在出口时须事先确认《外汇和对外贸易法》以及美国出口管理的相关法规，并办理相关手续。如有不明之处，请向敝司咨询。

多层陶瓷电容器



波峰焊

回流焊

■ 型号标示法

J	M	K	3	1	6	△	B	J	1	0	6	M	L	-	T	△
①	②	③	④	⑤	⑥	⑦	⑧	⑨	⑩	⑪	⑫					

△ = 空格

① 额定电压

代码	额定电压 [VDC]
P	2.5
A	4
J	6.3
L	10
E	16
T	25
G	35
U	50
H	100
Q	250
S	630

③ 端接类型

代码	端接类型
K	电镀
S	Cu 内部电极

② 系列名称

代码	系列名称
M	多层电容器
V	高频用多层电容器
W	LW 逆转型多层电容器

④ 外型尺寸

规格	L×W [mm]	EIA (inch)
021	0.25 × 0.125	008004
042	0.4 × 0.2	01005
063	0.6 × 0.3	0201
105	1.0 × 0.5	0402
	0.52 × 1.0 ※	0204
107	1.6 × 0.8	0603
	0.8 × 1.6 ※	0306
212	2.0 × 1.25	0805
	1.25 × 2.0 ※	0508
316	3.2 × 1.6	1206
325	3.2 × 2.5	1210
432	4.5 × 3.2	1812

注: ※LW 逆转型 (□WK)

⑤ 产品尺寸公差

代码	规格	L [mm]	W [mm]	T [mm]
△	所有规格	标准	标准	标准
A	063	0.6±0.05	0.3±0.05	0.3±0.05
	105	1.0±0.10	0.5±0.10	0.5±0.10
	107	1.6+0.15/-0.05	0.8+0.15/-0.05	0.8+0.15/-0.05
	212	2.0+0.15/-0.05	1.25+0.15/-0.05	0.45±0.05
				0.85±0.10
				1.25+0.15/-0.05
316	3.2±0.20	1.6±0.20	0.85±0.10	
325	3.2±0.30	2.5±0.30	1.6±0.20	
B	063	0.6±0.09	0.3±0.09	0.3±0.09
	105	1.0+0.15/-0.05	0.5+0.15/-0.05	0.5+0.15/-0.05
	107	1.6+0.20/-0	0.8+0.20/-0	0.45±0.05
				0.8+0.20/-0
	212	2.0+0.20/-0	1.25+0.20/-0	0.45±0.05
0.85±0.10				
316	3.2±0.30	1.6±0.30	1.25+0.20/-0	
C	105	1.0+0.20/-0	0.5+0.20/-0	1.6±0.30
				0.5+0.20/-0

注: P.6 标准产品尺寸

△ = 空格

⑥ 温度特性

■ 高介电常数【超低失真多层陶瓷电容器 除外】

代码	适用标准		温度范围 [°C]	基准温度 [°C]	静电容量变化率	静电容量允许偏差	允许偏差代码
BJ	JIS	B	-25~+85	20	±10%	±10%	K
	EIA	X5R	-55~+85	25	±15%	±20%	M
B7	EIA	X7R	-55~+125	25	±15%	±10%	K
						±20%	M
C6	EIA	X6S	-55~+105	25	±22%	±10%	K
						±20%	M
C7	EIA	X7S	-55~+125	25	±22%	±10%	K
						±20%	M
LD(※)	EIA	X5R	-55~+85	25	±15%	±10%	K
						±20%	M

注: ※LD 低失真大容量多层陶瓷电容器

△ = 空格

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■ 温度补偿用

代码	适用标准		温度范围 [°C]	基准温度 [°C]	静电容量变化率	静电容量允许偏差	允许偏差代码
CG	EIA	C0G	-55~+125	25	0±30ppm/°C	±0.05pF	A
						±0.1pF	B
						±0.25pF	C
						±0.5pF	D
						±5%	J
UJ	JIS	UJ	-55~+125	20	-750±120ppm/°C	±0.25pF	C
						±0.5pF	D
	EIA	U2J		25		±5%	J
UK	JIS	UK	-55~+125	20	-750±250ppm/°C	±0.25pF	C
	EIA	U2K	-55~+125	25			
SL	JIS	SL	-55~+125	20	+350~-1000ppm/°C	±5%	J

⑥ 系列名称

· 超低失真多层陶瓷电容器

代码	系列名称
SD	标准品

· 中高耐压多层陶瓷电容器

代码	系列名称
SD	标准品

⑦ 静电容量

代码 (例)	静电容量
0R5	0.5pF
010	1pF
100	10pF
101	100pF
102	1,000pF
103	10,000pF
104	0.1 μF
105	1.0 μF
106	10 μF
107	100 μF

注: R=小数点

⑧ 静电容量允许偏差

代码	静电容量允许偏差
A	±0.05pF
B	±0.1pF
C	±0.25pF
D	±0.5pF
F	±1pF
G	±2%
J	±5%
K	±10%
M	±20%
Z	+80/-20%

⑨ 产品厚度

代码	产品厚度 [mm]
K	0.125
H	0.13
E	0.18
C	0.2
D	
P	0.3
T	
K	0.45 (107 型以上)
V	0.5
W	
A	0.8
D	0.85 (212 型以上)
F	1.15
G	1.25
L	1.6
N	1.9
Y	2.0 max
M	2.5

⑩ 个别规格

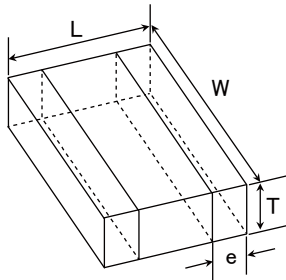
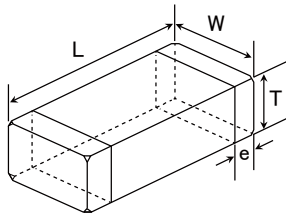
代码	个别规格
-	标准

⑪ 包装

代码	包装规格
F	φ178mm 卷盘带装 (2mm 间距)
T	φ178mm 卷盘带装 (4mm 间距)
P	φ178mm 卷盘带装 (4mm 间距, 1000 个/卷盘) 325 规格 (厚度代码M)
R	φ178mm 卷盘带装 (2mm 间距) 105 规格 (厚度代码E,H)
W	φ178mm 压纹带 (1mm 间距) 021/042 规格专用

⑫ 管理记号

代码	管理记号
△	标准



※ LW逆转型

Type (EIA)	标准产品尺寸[mm]				
	L	W	T	*1	e
□MK021(008004)	0.25±0.013	0.125±0.013	0.125±0.013	K	0.0675±0.0275
□MK042(01005)	0.4±0.02	0.2±0.02	0.2±0.02	C	0.1±0.03
				D	
□VS042(01005)	0.4±0.02	0.2±0.02	0.2±0.02	C	0.1±0.03
□MK063(0201)	0.6±0.03	0.3±0.03	0.3±0.03	P	0.15±0.05
				T	
□MK105(0402)	1.0±0.05	0.5±0.05	0.13±0.02	H	0.25±0.10
			0.18±0.02	E	
			0.2±0.02	C	
			0.3±0.03	P	
			0.5±0.05	V	
□VK105(0402)	1.0±0.05	0.5±0.05	0.5±0.05	W	0.25±0.10
□WK105(0204)※	0.52±0.05	1.0±0.05	0.3±0.05	P	0.18±0.08
□MK107(0603)	1.6±0.10	0.8±0.10	0.45±0.05	K	0.35±0.25
			0.8±0.10	A	
□WK107(0306)※	0.8±0.10	1.6±0.10	0.5±0.05	V	0.25±0.15
□MK212(0805)	2.0±0.10	1.25±0.10	0.45±0.05	K	0.5±0.25
			0.85±0.10	D	
			1.25±0.10	G	
□WK212(0508)※	1.25±0.15	2.0±0.15	0.85±0.10	D	0.3±0.2
□MK316(1206)	3.2±0.15	1.6±0.15	0.85±0.10	D	0.5+0.35/-0.25
			1.15±0.10	F	
			1.6±0.20	L	
□MK325(1210)	3.2±0.30	2.5±0.20	0.85±0.10	D	0.6±0.3
			1.15±0.10	F	
			1.9±0.20	N	
			1.9+0.1/-0.2	Y	
□MK432(1812)	4.5±0.40	3.2±0.30	2.5±0.20	M	0.9±0.6

注: ※LW 逆转型、*1 产品厚度代码

■标准包装

规格	EIA (inch)	产品厚度		标准数量 [pcs]	
		[mm]	代码	纸带	压纹带
021	008004	0.125	K	—	50000
042	01005	0.2	C	—	40000
			D		
063	0201	0.3	P	15000	—
			T		
105	0402	0.13	H	—	20000
			E		
			C		
			P		
			V		
	0204 ※	0.30	P	10000	—
107	0603	0.45	K	4000	—
			A		
212	0805	0.85	D	4000	—
			G		
316	1206	1.15	F	—	3000
			L		
			2000		
325	1210	1.9	N	—	2000
			Y		
			M		
			1000		
432	1812	2.5	M	—	500

注: ※LW 逆转型 (□WK)

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■ 型号一览

- 本产品目录中记载的多层陶瓷电容器全部是RoHS对应品。
- 请在型号的□中指定静电容量允许偏差代码。

注)

- *1 根据个别规格的约定, 也会有采取温度特性为X7R/X7S的产品对应的情况。
- *2 根据使用电路和机器, 需要按照相应规格处理。请务必咨询正规销售渠道。
- *3 关于尺寸规格, 请参照型号标示法的④外形尺寸、⑤产品尺寸公差、⑨产品厚度、P.6标准产品尺寸。

多层陶瓷电容器 (高介电常数)

● 021型

【温度特性 BJ : X5R】 厚度0.125mm (K)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^④ [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
EMK021 BJ221□K-W		16	X5R	220 p	±10, ±20	10	150	0.125±0.013	R
EMK021 BJ471□K-W			X5R	470 p	±10, ±20	10	150	0.125±0.013	R
EMK021 BJ102□K-W			X5R	1000 p	±10, ±20	10	150	0.125±0.013	R
JMK021 BJ222□K-W		6.3	X5R	2200 p	±10, ±20	10	150	0.125±0.013	R
JMK021 BJ472□K-W			X5R	4700 p	±10, ±20	10	150	0.125±0.013	R
JMK021 BJ103□K-W			X5R	0.01 μ	±10, ±20	10	150	0.125±0.013	R
AMK021 BJ223MK-W		4	X5R	0.022 μ	±20	10	150	0.125±0.013	R

● 042型

【温度特性 BJ : B/X5R】 厚度0.2mm (C)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^④ [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
EMK042 BJ101□C-W		16	B X5R	100 p	±10, ±20	5	200	0.2±0.02	R
EMK042 BJ151□C-W			B X5R	150 p	±10, ±20	5	200	0.2±0.02	R
EMK042 BJ221□C-W			B X5R	220 p	±10, ±20	5	200	0.2±0.02	R
EMK042 BJ331□C-W			B X5R	330 p	±10, ±20	5	200	0.2±0.02	R
EMK042 BJ471□C-W			B X5R	470 p	±10, ±20	5	200	0.2±0.02	R
EMK042 BJ681□C-W			B X5R	680 p	±10, ±20	5	200	0.2±0.02	R
EMK042 BJ102□C-W			B X5R	1000 p	±10, ±20	5	200	0.2±0.02	R
EMK042 BJ152□C-W			X5R	1500 p	±10, ±20	10	150	0.2±0.02	R
EMK042 BJ222□C-W			X5R	2200 p	±10, ±20	10	150	0.2±0.02	R
EMK042 BJ332□C-W			X5R	3300 p	±10, ±20	10	150	0.2±0.02	R
EMK042 BJ472□C-W			X5R	4700 p	±10, ±20	10	150	0.2±0.02	R
EMK042 BJ682□C-W			X5R	6800 p	±10, ±20	10	150	0.2±0.02	R
EMK042 BJ103□C-W			X5R	0.01 μ	±10, ±20	10	150	0.2±0.02	R
LMK042 BJ101□C-W			B X5R ^①	100 p	±10, ±20	5	200	0.2±0.02	R
LMK042 BJ151□C-W			B X5R ^①	150 p	±10, ±20	5	200	0.2±0.02	R
LMK042 BJ221□C-W			B X5R ^①	220 p	±10, ±20	5	200	0.2±0.02	R
LMK042 BJ331□C-W		B X5R ^①	330 p	±10, ±20	5	200	0.2±0.02	R	
LMK042 BJ471□C-W		B X5R ^①	470 p	±10, ±20	5	200	0.2±0.02	R	
LMK042 BJ681□C-W		B X5R ^①	680 p	±10, ±20	5	200	0.2±0.02	R	
LMK042 BJ102□C-W		B X5R ^①	1000 p	±10, ±20	5	200	0.2±0.02	R	
LMK042 BJ152□C-W		X5R	1500 p	±10, ±20	10	150	0.2±0.02	R	
LMK042 BJ222□C-W		X5R	2200 p	±10, ±20	10	150	0.2±0.02	R	
LMK042 BJ332□C-W		X5R	3300 p	±10, ±20	10	150	0.2±0.02	R	
LMK042 BJ472□C-W		X5R	4700 p	±10, ±20	10	150	0.2±0.02	R	
LMK042 BJ682□C-W		X5R	6800 p	±10, ±20	10	150	0.2±0.02	R	
LMK042 BJ103□C-W		X5R	0.01 μ	±10, ±20	10	150	0.2±0.02	R	
JMK042 BJ152□C-W		6.3	B X5R ^①	1500 p	±10, ±20	10	150	0.2±0.02	R
JMK042 BJ222□C-W			B X5R ^①	2200 p	±10, ±20	10	150	0.2±0.02	R
JMK042 BJ332□C-W			B X5R ^①	3300 p	±10, ±20	10	150	0.2±0.02	R
JMK042 BJ472□C-W			B X5R ^①	4700 p	±10, ±20	10	150	0.2±0.02	R
JMK042 BJ682□C-W			B X5R ^①	6800 p	±10, ±20	10	150	0.2±0.02	R
JMK042 BJ103□C-W			B X5R ^①	0.01 μ	±10, ±20	10	150	0.2±0.02	R
JMK042 BJ223□C-W			X5R	0.022 μ	±10, ±20	10	150	0.2±0.02	R
JMK042 BJ473□C-W			X5R	0.047 μ	±10, ±20	10	150	0.2±0.02	R
JMK042 BJ104□C-W			X5R	0.1 μ	±10, ±20	10	150	0.2±0.02	R
AMK042 BJ473□C-W			X5R	0.047 μ	±10, ±20	10	150	0.2±0.02	R
AMK042 BJ104□C-W		4	X5R	0.1 μ	±10, ±20	10	150	0.2±0.02	R

【温度特性 B7 : X7R】 厚度0.2mm (C)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^④ [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
EMK042 B7101□C-W		16	X7R	100 p	±10, ±20	5	200	0.2±0.02	R
EMK042 B7151□C-W			X7R	150 p	±10, ±20	5	200	0.2±0.02	R
EMK042 B7221□C-W			X7R	220 p	±10, ±20	5	200	0.2±0.02	R
EMK042 B7331□C-W			X7R	330 p	±10, ±20	5	200	0.2±0.02	R
EMK042 B7471□C-W			X7R	470 p	±10, ±20	5	200	0.2±0.02	R
EMK042 B7681□C-W			X7R	680 p	±10, ±20	5	200	0.2±0.02	R
EMK042 B7102□C-W			X7R	1000 p	±10, ±20	5	200	0.2±0.02	R
LMK042 B7101□C-W			X7R	100 p	±10, ±20	5	200	0.2±0.02	R
LMK042 B7151□C-W			X7R	150 p	±10, ±20	5	200	0.2±0.02	R
LMK042 B7221□C-W			X7R	220 p	±10, ±20	5	200	0.2±0.02	R
LMK042 B7331□C-W		10	X7R	330 p	±10, ±20	5	200	0.2±0.02	R
LMK042 B7471□C-W			X7R	470 p	±10, ±20	5	200	0.2±0.02	R
LMK042 B7681□C-W			X7R	680 p	±10, ±20	5	200	0.2±0.02	R
LMK042 B7102□C-W			X7R	1000 p	±10, ±20	5	200	0.2±0.02	R

▶ 由于篇幅有限, 本产品目录中只记载了有代表性的产品规格, 若考虑使用弊公司产品时, 请确认交货规格说明书中的详细规格。另外, 有关各产品的详细信息(特性图、可靠性信息、使用时的注意事项等), 请参阅弊公司网站 (<http://www.ty-top.com/>)。

● O63型

【温度特性 BJ : B/X5R】 厚度 0.3mm (P)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊		
								额定电压 x %				
UMK063 BJ101□P-F		50	B	X5R ^{±1}	100 p	±10, ±20	3.5	200	0.3±0.03	R		
UMK063 BJ151□P-F			B	X5R ^{±1}	150 p	±10, ±20	3.5	200	0.3±0.03	R		
UMK063 BJ221□P-F			B	X5R ^{±1}	220 p	±10, ±20	3.5	200	0.3±0.03	R		
UMK063 BJ331□P-F			B	X5R ^{±1}	330 p	±10, ±20	3.5	200	0.3±0.03	R		
UMK063 BJ471□P-F			B	X5R ^{±1}	470 p	±10, ±20	3.5	200	0.3±0.03	R		
UMK063 BJ681□P-F			B	X5R ^{±1}	680 p	±10, ±20	3.5	200	0.3±0.03	R		
UMK063 BJ102□P-F			B	X5R ^{±1}	1000 p	±10, ±20	3.5	200	0.3±0.03	R		
UMK063 BJ152□P-F			B	X5R	1500 p	±10, ±20	5	200	0.3±0.03	R		
UMK063 BJ222□P-F			B	X5R	2200 p	±10, ±20	5	200	0.3±0.03	R		
UMK063 BJ332□P-F			B	X5R	3300 p	±10, ±20	5	200	0.3±0.03	R		
UMK063 BJ472□P-F			B	X5R	4700 p	±10, ±20	5	200	0.3±0.03	R		
UMK063 BJ682□P-F			B	X5R	6800 p	±10, ±20	5	200	0.3±0.03	R		
UMK063 BJ103□P-F			B	X5R	0.01 μ	±10, ±20	5	200	0.3±0.03	R		
GMK063 BJ104□P-F			35		X5R	0.1 μ	±10, ±20	10	150	0.3±0.03	R	
TMK063 BJ152□P-F				B	X5R	1500 p	±10, ±20	5	200	0.3±0.03	R	
TMK063 BJ222□P-F				B	X5R	2200 p	±10, ±20	5	200	0.3±0.03	R	
TMK063 BJ332□P-F				B	X5R	3300 p	±10, ±20	5	200	0.3±0.03	R	
TMK063 BJ472□P-F				B	X5R	4700 p	±10, ±20	5	200	0.3±0.03	R	
TMK063 BJ682□P-F		B		X5R	6800 p	±10, ±20	5	200	0.3±0.03	R		
TMK063 BJ103□P-F		B		X5R	0.01 μ	±10, ±20	5	200	0.3±0.03	R		
TMK063 BJ223□P-F		B		X5R	0.022 μ	±10, ±20	7.5	150	0.3±0.03	R		
TMK063ABJ104□P-F				X5R	0.1 μ	±10, ±20	10	150	0.3±0.05	R		
EMK063 BJ152□P-F		16		B	X5R ^{±1}	1500 p	±10, ±20	5	200	0.3±0.03	R	
EMK063 BJ222□P-F				B	X5R ^{±1}	2200 p	±10, ±20	5	200	0.3±0.03	R	
EMK063 BJ332□P-F				B	X5R ^{±1}	3300 p	±10, ±20	5	200	0.3±0.03	R	
EMK063 BJ472□P-F				B	X5R ^{±1}	4700 p	±10, ±20	5	200	0.3±0.03	R	
EMK063 BJ682□P-F				B	X5R ^{±1}	6800 p	±10, ±20	5	200	0.3±0.03	R	
EMK063 BJ103□P-F				B	X5R ^{±1}	0.01 μ	±10, ±20	5	200	0.3±0.03	R	
EMK063 BJ223□P-F				B	X5R	0.022 μ	±10, ±20	7.5	150	0.3±0.03	R	
EMK063 BJ333□P-F					X5R	0.033 μ	±10, ±20	7.5	150	0.3±0.03	R	
EMK063 BJ473□P-F					X5R	0.047 μ	±10, ±20	7.5	150	0.3±0.03	R	
EMK063 BJ683□P-F				X5R	0.068 μ	±10, ±20	10	150	0.3±0.03	R		
EMK063 BJ104□P-F				X5R	0.1 μ	±10, ±20	10	150	0.3±0.03	R		
EMK063 BJ224□P-F				X5R	0.22 μ	±10, ±20	10	150	0.3±0.03	R		
EMK063 BJ333□P-F			10	B	X5R	0.022 μ	±10, ±20	7.5	150	0.3±0.03	R	
EMK063 BJ473□P-F					X5R	0.033 μ	±10, ±20	7.5	150	0.3±0.03	R	
EMK063 BJ683□P-F					X5R	0.047 μ	±10, ±20	7.5	150	0.3±0.03	R	
EMK063 BJ104□P-F					X5R	0.068 μ	±10, ±20	10	150	0.3±0.03	R	
EMK063 BJ224□P-F					X5R	0.1 μ	±10, ±20	10	150	0.3±0.03	R	
EMK063 BJ334MP-F					X5R	0.22 μ	±10, ±20	10	150	0.3±0.03	R	
EMK063 BJ474□P-F				X5R	0.47 μ	±10, ±20	10	150	0.3±0.03	R		
EMK063ABJ105MPLF				X5R	1 μ	±20	10	150	0.3±0.09	R		
JMK063 BJ223□P-F		6.3		B	X5R	0.022 μ	±10, ±20	7.5	150	0.3±0.03	R	
JMK063 BJ333□P-F					X5R	0.033 μ	±10, ±20	7.5	150	0.3±0.03	R	
JMK063 BJ473□P-F					X5R	0.047 μ	±10, ±20	7.5	150	0.3±0.03	R	
JMK063 BJ683□P-F					X5R	0.068 μ	±10, ±20	10	150	0.3±0.03	R	
JMK063 BJ104□P-F					X5R	0.1 μ	±10, ±20	10	150	0.3±0.03	R	
JMK063 BJ224□P-F					X5R	0.22 μ	±10, ±20	10	150	0.3±0.03	R	
JMK063 BJ334MP-F					X5R	0.33 μ	±20	10	150	0.3±0.03	R	
JMK063 BJ474□P-F					X5R	0.47 μ	±10, ±20	10	150	0.3±0.03	R	
JMK063ABJ105□P-F					X5R	1 μ	±10, ±20	10	150	0.3±0.05	R	
AMK063 BJ224□P-F				4		X5R	0.22 μ	±10, ±20	10	150	0.3±0.03	R
AMK063 BJ334MP-F						X5R	0.33 μ	±20	10	150	0.3±0.03	R
AMK063 BJ474□P-F						X5R	0.47 μ	±10, ±20	10	150	0.3±0.03	R
AMK063ABJ105□P-F						X5R	1 μ	±10, ±20	10	150	0.3±0.05	R

【温度特性 C6 : X6S】 厚度 0.3mm (P)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊		
								额定电压 x %				
TMK063 C6104□P-F		25		X6S	0.1 μ	±10, ±20	10	150	0.3±0.03	R		
EMK063AC6104□P-F		16		X6S	0.1 μ	±10, ±20	10	150	0.3±0.05	R		
LMK063 C6333□P-F					X6S	0.033 μ	±10, ±20	7.5	150	0.3±0.03	R	
LMK063 C6473□P-F			10		X6S	0.047 μ	±10, ±20	7.5	150	0.3±0.03	R	
LMK063 C6683□P-F						X6S	0.068 μ	±10, ±20	10	150	0.3±0.03	R
LMK063 C6104□P-F						X6S	0.1 μ	±10, ±20	10	150	0.3±0.03	R
LMK063 C6224□P-F						X6S	0.22 μ	±10, ±20	10	150	0.3±0.03	R
JMK063 C6223□P-F				6.3		X6S	0.022 μ	±10, ±20	7.5	200	0.3±0.03	R
JMK063 C6333□P-F							X6S	0.033 μ	±10, ±20	7.5	150	0.3±0.03
JMK063 C6473□P-F						X6S	0.047 μ	±10, ±20	7.5	150	0.3±0.03	R
JMK063 C6683□P-F						X6S	0.068 μ	±10, ±20	10	150	0.3±0.03	R
JMK063 C6104□P-F						X6S	0.1 μ	±10, ±20	10	150	0.3±0.03	R
JMK063 C6224□P-F						X6S	0.22 μ	±10, ±20	10	150	0.3±0.03	R
JMK063BC6105MP-F			4		X6S	1 μ	±20	10	150	0.3±0.09	R	
AMK063 C6474□P-F						X6S	0.47 μ	±10, ±20	10	150	0.3±0.03	R
AMK063AC6105□P-F						X6S	1 μ	±10, ±20	10	150	0.3±0.05	R

【温度特性 B7 : X7R】 厚度 0.3mm (P)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊	
								额定电压 x %			
UMK063 B7101□P-F		50		X7R	100 p	±10, ±20	3.5	200	0.3±0.03	R	
UMK063 B7151□P-F					X7R	150 p	±10, ±20	3.5	200	0.3±0.03	R
UMK063 B7221□P-F					X7R	220 p	±10, ±20	3.5	200	0.3±0.03	R
UMK063 B7331□P-F					X7R	330 p	±10, ±20	3.5	200	0.3±0.03	R
UMK063 B7471□P-F					X7R	470 p	±10, ±20	3.5	200	0.3±0.03	R
UMK063 B7681□P-F					X7R	680 p	±10, ±20	3.5	200	0.3±0.03	R
UMK063 B7102□P-F					X7R	1000 p	±10, ±20	3.5	200	0.3±0.03	R

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■ 型号一览

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^③ [mm]	焊接方式 R: 回流焊 W: 波峰焊	
								额定电压 x %			
TMK063 B7152□P-F		25		X7R	1500 p	±10, ±20	5	200	0.3±0.03	R	
TMK063 B7222□P-F				X7R	2200 p	±10, ±20	5	200	0.3±0.03	R	
TMK063 B7332□P-F			X7R	3300 p	±10, ±20	5	200	0.3±0.03	R		
TMK063 B7472□P-F			X7R	4700 p	±10, ±20	5	200	0.3±0.03	R		
TMK063 B7682□P-F			X7R	6800 p	±10, ±20	5	200	0.3±0.03	R		
TMK063 B7103□P-F			X7R	0.01 μ	±10, ±20	5	200	0.3±0.03	R		
EMK063 B7152□P-F			16		X7R	1500 p	±10, ±20	5	200	0.3±0.03	R
EMK063 B7222□P-F					X7R	2200 p	±10, ±20	5	200	0.3±0.03	R
EMK063 B7332□P-F				X7R	3300 p	±10, ±20	5	200	0.3±0.03	R	
EMK063 B7472□P-F				X7R	4700 p	±10, ±20	5	200	0.3±0.03	R	
EMK063 B7682□P-F		X7R		6800 p	±10, ±20	5	200	0.3±0.03	R		
EMK063 B7103□P-F		X7R		0.01 μ	±10, ±20	5	200	0.3±0.03	R		
EMK063 B7223□P-F		X7R		0.022 μ	±10, ±20	7.5	150	0.3±0.03	R		

● 105型

【温度特性 BJ: B/X5R】 厚度 0.5mm (V)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^③ [mm]	焊接方式 R: 回流焊 W: 波峰焊	
								额定电压 x %			
UMK105 BJ221□V-F		50	B	X5R ^①	220 p	±10, ±20	2.5	200	0.5±0.05	R	
UMK105 BJ331□V-F				X5R ^①	330 p	±10, ±20	2.5	200	0.5±0.05	R	
UMK105 BJ471□V-F			B	X5R ^①	470 p	±10, ±20	2.5	200	0.5±0.05	R	
UMK105 BJ681□V-F			B	X5R ^①	680 p	±10, ±20	2.5	200	0.5±0.05	R	
UMK105 BJ102□V-F			B	X5R ^①	1000 p	±10, ±20	2.5	200	0.5±0.05	R	
UMK105 BJ152□V-F			B	X5R ^①	1500 p	±10, ±20	2.5	200	0.5±0.05	R	
UMK105 BJ222□V-F			B	X5R ^①	2200 p	±10, ±20	2.5	200	0.5±0.05	R	
UMK105 BJ333□V-F			B	X5R ^①	3300 p	±10, ±20	2.5	200	0.5±0.05	R	
UMK105 BJ472□V-F			B	X5R ^①	4700 p	±10, ±20	2.5	200	0.5±0.05	R	
UMK105 BJ682□V-F			B	X5R ^①	6800 p	±10, ±20	2.5	150	0.5±0.05	R	
UMK105 BJ103□V-F			B	X5R ^①	0.01 μ	±10, ±20	3.5	200	0.5±0.05	R	
UMK105 BJ104□V-F				X5R	0.1 μ	±10, ±20	10	150	0.5±0.05	R	
UMK105 BJ224□V-F				X5R	0.22 μ	±10, ±20	10	150	0.5±0.05	R	
UMK105ABJ474□V-F				X5R	0.47 μ	±10, ±20	10	150	0.5±0.10	R	
UMK105CBJ105MV-F				X5R	1 μ	±20	10	150	0.5+0.20/-0	R	
GMK105 BJ104□V-F			35	B	X5R	0.1 μ	±10, ±20	5	150	0.5±0.05	R
GMK105ABJ105□V-F					X5R	1 μ	±10, ±20	10	150	0.5±0.10	R
TMK105 BJ153□V-F			25	B	X5R ^①	0.015 μ	±10, ±20	3.5	200	0.5±0.05	R
TMK105 BJ223□V-F					X5R ^①	0.022 μ	±10, ±20	3.5	200	0.5±0.05	R
TMK105 BJ333□V-F				B	X5R ^①	0.033 μ	±10, ±20	3.5	150	0.5±0.05	R
TMK105 BJ473□V-F		B		X5R ^①	0.047 μ	±10, ±20	3.5	150	0.5±0.05	R	
TMK105 BJ104□V-F		B		X5R	0.1 μ	±10, ±20	5	150	0.5±0.05	R	
TMK105 BJ224□V-F				X5R	0.22 μ	±10, ±20	10	200	0.5±0.05	R	
TMK105ABJ474□V-F				X5R	0.47 μ	±10, ±20	10	200	0.5±0.10	R	
TMK105 BJ105□V-F				X5R	1 μ	±10, ±20	10	150	0.5±0.05	R	
TMK105CBJ225□V-F				X5R	2.2 μ	±10, ±20	10	150	0.5+0.20/-0	R	
EMK105 BJ153□V-F		16		B	X5R ^①	0.015 μ	±10, ±20	3.5	200	0.5±0.05	R
EMK105 BJ223□V-F			B		X5R ^①	0.022 μ	±10, ±20	3.5	200	0.5±0.05	R
EMK105 BJ333□V-F			B	X5R ^①	0.033 μ	±10, ±20	3.5	200	0.5±0.05	R	
EMK105 BJ473□V-F			B	X5R ^①	0.047 μ	±10, ±20	3.5	200	0.5±0.05	R	
EMK105 BJ683□V-F			B	X5R	0.068 μ	±10, ±20	5	200	0.5±0.05	R	
EMK105 BJ104□V-F			B	X5R ^①	0.1 μ	±10, ±20	5	150	0.5±0.05	R	
EMK105 BJ224□V-F			B	X5R	0.22 μ	±10, ±20	5	150	0.5±0.05	R	
EMK105ABJ474□V-F				X5R	0.47 μ	±10, ±20	10	150	0.5±0.10	R	
EMK105 BJ105□V-F				X5R	1 μ	±10, ±20	10	150	0.5±0.05	R	
EMK105ABJ225□V-F				X5R	2.2 μ	±10, ±20	10	150	0.5±0.10	R	
Lmk105 BJ104□V-F		10	B	X5R	0.1 μ	±10, ±20	5	200	0.5±0.05	R	
Lmk105 BJ224□V-F				B	X5R	0.22 μ	±10, ±20	5	150	0.5±0.05	R
Lmk105 BJ474□V-F				X5R	0.47 μ	±10, ±20	10	150	0.5±0.05	R	
Lmk105 BJ105□V-F				X5R	1 μ	±10, ±20	10	150	0.5±0.05	R	
Lmk105 BJ225□V-F			X5R	2.2 μ	±10, ±20	10	150	0.5±0.05	R		
Lmk105BBJ475MVL-F			X5R	4.7 μ	±20	10	150	0.5+0.15/-0.05	R		
JMK105 BJ224□V-F		6.3	B	X5R	0.22 μ	±10, ±20	5	150	0.5±0.05	R	
JMK105 BJ474□V-F				X5R	0.47 μ	±10, ±20	10	150	0.5±0.05	R	
JMK105 BJ105□V-F				X5R	1 μ	±10, ±20	10	150	0.5±0.05	R	
JMK105 BJ225□V-F				X5R	2.2 μ	±10, ±20	10	150	0.5±0.05	R	
JMK105BBJ475MV-F	JMK105 BJ475MV-FD			X5R	4.7 μ	±20	10	150	0.5+0.15/-0.05	R	
JMK105CBJ106MV-F				X5R	10 μ	±20	10	150	0.5+0.20/-0	R	
AMK105ABJ475MV-F	AMK105 BJ475MV-F	4		X5R	4.7 μ	±20	10	150	0.5±0.10	R	
AMK105CBJ106MV-F				X5R	10 μ	±20	10	150	0.5+0.20/-0	R	

【温度特性 BJ: B/X5R】 厚度 0.3mm (P)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^③ [mm]	焊接方式 R: 回流焊 W: 波峰焊	
								额定电压 x %			
UMK105 BJ104□P-F		50	B	X5R	0.1 μ	±10, ±20	10	150	0.3±0.03	R	
TMK105 BJ103□P-F				X5R	0.01 μ	±10, ±20	5	150	0.3±0.03	R	
TMK105 BJ104□P-F			25		X5R	0.1 μ	±10, ±20	10	150	0.3±0.03	R
TMK105 BJ224□P-F					X5R	0.22 μ	±10, ±20	10	150	0.3±0.03	R
TMK105 BJ474□P-F		16		X5R	0.47 μ	±10, ±20	10	150	0.3±0.03	R	
EMK105 BJ474□P-F				X5R	0.47 μ	±10, ±20	10	150	0.3±0.03	R	
Lmk105 BJ105□PL-F		10		X5R	1 μ	±10, ±20	10	150	0.3±0.03	R	
JMK105 BJ105□P-F		6.3		X5R	1 μ	±10, ±20	10	150	0.3±0.03	R	
AMK105 BJ225MP-F		4		X5R	2.2 μ	±20	10	150	0.3±0.03	R	

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【温度特性 BJ: X5R】厚度 0.2mm (C)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
LMK105 BJ104□C-F		10	X5R	0.1 μ	±10, ±20	10	150	0.2±0.02	R
JMK105 BJ224□C-F		6.3	X5R	0.22 μ	±10, ±20	10	150	0.2±0.02	R
JMK105 BJ474□C-F			X5R	0.47 μ	±10, ±20	10	150	0.2±0.02	R
JMK105 BJ105MC-F			X5R	1 μ	±20	10	150	0.2±0.02	R

【温度特性 BJ: X5R】厚度 0.18mm (E)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
LMK105 BJ104□E-R		10	X5R	0.1 μ	±10, ±20	10	150	0.18±0.02	R
JMK105 BJ224□E-R		6.3	X5R	0.22 μ	±10, ±20	10	150	0.18±0.02	R
JMK105 BJ474□E-R			X5R	0.47 μ	±10, ±20	10	150	0.18±0.02	R
AMK105 BJ105ME-R		4	X5R	1 μ	±20	10	150	0.18±0.02	R

【温度特性 BJ: X5R】厚度 0.13mm (H)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
LMK105 BJ104MH-R		10	X5R	0.1 μ	±20	10	150	0.13±0.02	R
JMK105 BJ224MH-R		6.3	X5R	0.22 μ	±20	10	150	0.13±0.02	R
AMK105 BJ474MH-R			X5R	0.47 μ	±20	10	150	0.13±0.02	R

【温度特性 C6: X6S】厚度 0.5mm (V)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
GMK105CC6105MV-F		35	X6S	1 μ	±20	10	150	0.5+0.20/-0	R
TMK105AC6105□V-F		25	X6S	1 μ	±10, ±20	10	150	0.5±0.10	R
EMK105 C6105□V-F			X6S	1 μ	±10, ±20	10	150	0.5±0.05	R
EMK105CC6225MV-F		16	X6S	2.2 μ	±20	10	150	0.5+0.20/-0	R
LMK105 C6105□V-F			X6S	1 μ	±10, ±20	10	200	0.5±0.05	R
LMK105AC6225MV-F		10	X6S	2.2 μ	±20	10	150	0.5±0.10	R
JMK105 C6105□V-F			X6S	1 μ	±10, ±20	10	150	0.5±0.05	R
JMK105 C6225MV-F			X6S	2.2 μ	±20	10	150	0.5±0.05	R
JMK105BC6475MV-F		6.3	X6S	4.7 μ	±20	10	150	0.5+0.15/-0.05	R
AMK105BC6475MV-F			X6S	4.7 μ	±20	10	150	0.5+0.15/-0.05	R

【温度特性 B7: X7R】厚度 0.5mm (V)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
UMK105 B7221□V-F		50	X7R	220 p	±10, ±20	2.5	200	0.5±0.05	R
UMK105 B7331□V-F			X7R	330 p	±10, ±20	2.5	200	0.5±0.05	R
UMK105 B7471□V-F			X7R	470 p	±10, ±20	2.5	200	0.5±0.05	R
UMK105 B7681□V-F			X7R	680 p	±10, ±20	2.5	200	0.5±0.05	R
UMK105 B7102□V-F			X7R	1000 p	±10, ±20	2.5	200	0.5±0.05	R
UMK105 B7152□V-F			X7R	1500 p	±10, ±20	2.5	200	0.5±0.05	R
UMK105 B7222□V-F			X7R	2200 p	±10, ±20	2.5	200	0.5±0.05	R
UMK105 B7332□V-F			X7R	3300 p	±10, ±20	2.5	200	0.5±0.05	R
UMK105 B7472□V-F			X7R	4700 p	±10, ±20	2.5	200	0.5±0.05	R
UMK105 B7682□V-F			X7R	6800 p	±10, ±20	2.5	200	0.5±0.05	R
UMK105 B7103□V-F			X7R	0.01 μ	±10, ±20	3.5	200	0.5±0.05	R
UMK105 B7223□V-FR			X7R	0.022 μ	±10, ±20	10	200	0.5±0.05	R
UMK105 B7473□V-FR			X7R	0.047 μ	±10, ±20	10	200	0.5±0.05	R
UMK105 B7104□V-FR			X7R	0.1 μ	±10, ±20	10	150	0.5±0.05	R
TMK105 B7152□V-F			25	X7R	1500 p	±10, ±20	2.5	200	0.5±0.05
TMK105 B7222□V-F		X7R		2200 p	±10, ±20	2.5	200	0.5±0.05	R
TMK105 B7332□V-F		X7R		3300 p	±10, ±20	2.5	200	0.5±0.05	R
TMK105 B7472□V-F		X7R		4700 p	±10, ±20	2.5	200	0.5±0.05	R
TMK105 B7682□V-F		X7R		6800 p	±10, ±20	2.5	200	0.5±0.05	R
TMK105 B7103□V-F		X7R		0.01 μ	±10, ±20	3.5	200	0.5±0.05	R
TMK105 B7223□V-F		X7R		0.022 μ	±10, ±20	3.5	150	0.5±0.05	R
TMK105 B7473□V-F		X7R		0.047 μ	±10, ±20	3.5	150	0.5±0.05	R
TMK105 B7104□V-FR		X7R		0.1 μ	±10, ±20	10	200	0.5±0.05	R
TMK105 B7224□V-FR		X7R		0.22 μ	±10, ±20	10	150	0.5±0.05	R
EMK105 B7223□V-F		16	X7R	0.022 μ	±10, ±20	3.5	200	0.5±0.05	R
EMK105 B7473□V-F			X7R	0.047 μ	±10, ±20	3.5	200	0.5±0.05	R
EMK105 B7104□V-F			X7R	0.1 μ	±10, ±20	5	150	0.5±0.05	R
EMK105 B7224□V-FR		10	X7R	0.22 μ	±10, ±20	10	150	0.5±0.05	R
LMK105 B7223□V-F			X7R	0.022 μ	±10, ±20	3.5	200	0.5±0.05	R
LMK105 B7473□V-F			X7R	0.047 μ	±10, ±20	3.5	200	0.5±0.05	R
LMK105 B7104□V-F			X7R	0.1 μ	±10, ±20	5	150	0.5±0.05	R
LMK105 B7224□V-FR			X7R	0.22 μ	±10, ±20	10	150	0.5±0.05	R
LMK105 B7474□V-F			X7R	0.47 μ	±10, ±20	10	150	0.5±0.05	R
JMK105 B7224□V-F		6.3	X7R	0.22 μ	±10, ±20	5	150	0.5±0.05	R
JMK105 B7474□V-F			X7R	0.47 μ	±10, ±20	10	150	0.5±0.05	R

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【温度特性 C7 : X7S】厚度 1.6mm (L)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^{※3} [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
AMK316AC7476ML-T		4	X7S	47 μ	±20	10	150	1.6±0.20	R

【温度特性 B7 : X7R】厚度 1.6mm (L)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^{※3} [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
UMK316 B7224□L-T		50	X7R	0.22 μ	±10, ±20	2.5	200	1.6±0.20	R/W
UMK316 B7474□L-T			X7R	0.47 μ	±10, ±20	3.5	200	1.6±0.20	R/W
UMK316 B7105□L-T			X7R	1 μ	±10, ±20	3.5	200	1.6±0.20	R
UMK316 B7225□L-T			X7R	2.2 μ	±10, ±20	10	150	1.6±0.20	R
UMK316AB7475□L-T	UMK316 B7475□L-T	35	X7R	4.7 μ	±10, ±20	10	150	1.6±0.20	R
GMK316AB7106□L-TR			X7R	10 μ	±10, ±20	10	150	1.6±0.20	R
TMK316 B7105□L-T			X7R	1 μ	±10, ±20	3.5	200	1.6±0.20	R/W
TMK316 B7225□L-T			X7R	2.2 μ	±10, ±20	3.5	200	1.6±0.20	R
TMK316AB7475□L-T	TMK316 B7475□L-T	25	X7R	4.7 μ	±10, ±20	10	200	1.6±0.20	R
TMK316AB7106□L-T	TMK316 B7106□L-TD		X7R	10 μ	±10, ±20	10	150	1.6±0.20	R
EMK316 B7225□L-T			X7R	2.2 μ	±10, ±20	3.5	200	1.6±0.20	R/W
EMK316 B7475□L-T			X7R	4.7 μ	±10, ±20	5	200	1.6±0.20	R
EMK316AB7106□L-T	EMK316 B7106□L-TD	16	X7R	10 μ	±10, ±20	10	200	1.6±0.20	R
EMK316BB7226ML-T			X7R	22 μ	±20	10	150	1.6±0.30	R
LMK316 B7225□L-T			X7R	2.2 μ	±10, ±20	3.5	200	1.6±0.20	R/W
LMK316 B7475□L-T			X7R	4.7 μ	±10, ±20	5	200	1.6±0.20	R
LMK316AB7106□L-T	LMK316 B7106□L-TD	10	X7R	10 μ	±10, ±20	10	200	1.6±0.20	R
LMK316AB7226□L-TR	LMK316 B7226□L-TD		X7R	22 μ	±10, ±20	10	150	1.6±0.20	R
JMK316 B7106□L-T			X7R	10 μ	±10, ±20	5	200	1.6±0.20	R

【温度特性 B7 : X7R】厚度 0.85mm (D)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^{※3} [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
UMK316 B7225□D-T		50	X7R	2.2 μ	±10, ±20	10	150	0.85±0.10	R
TMK316AB7475□D-T		25	X7R	4.7 μ	±10, ±20	10	150	0.85±0.10	R
LMK316AB7106MD-T		10	X7R	10 μ	±20	10	150	0.85±0.10	R

● 325型

【温度特性 BJ : B/X5R】厚度 2.5mm (M)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^{※3} [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
UMK325 BJ475□M-P		50	X5R	4.7 μ	±10, ±20	5	150	2.5±0.20	R
UMK325 BJ106□M-P			X5R	10 μ	±10, ±20	5	150	2.5±0.20	R
GMK325 BJ226MM-P		35	X5R	22 μ	±20	10	150	2.5±0.20	R
TMK325 BJ106□M-P			B X5R ^{※1}	10 μ	±10, ±20	3.5	150	2.5±0.20	R
TMK325 BJ226□M-P		25	X5R	22 μ	±10, ±20	5	150	2.5±0.20	R
TMK325ABJ476MM-P			X5R	47 μ	±20	10	150	2.5±0.30	R
EMK325 BJ226□M-P			B X5R	22 μ	±10, ±20	5	150	2.5±0.20	R
EMK325 BJ476MM-P			X5R	47 μ	±20	10	150	2.5±0.20	R
EMK325ABJ107MM-P		16	X5R	100 μ	±20	10	150	2.5±0.30	R
LMK325 BJ226□M-P			B X5R	22 μ	±10, ±20	5	200	2.5±0.20	R
LMK325 BJ476MM-P			X5R	47 μ	±20	10	150	2.5±0.20	R
LMK325ABJ107MM-P	LMK325 BJ107MM-P		X5R	100 μ	±20	10	150	2.5±0.30	R
JMK325 BJ476MM-P		6.3	X5R	47 μ	±20	10	150	2.5±0.20	R
JMK325ABJ107MM-P	JMK325 BJ107MM-P		X5R	100 μ	±20	10	150	2.5±0.30	R
JMK325ABJ157MM-P			X5R	150 μ	±20	10	150	2.5±0.30	R
JMK325ABJ227MM-P			X5R	220 μ	±20	10	150	2.5±0.30	R
JMK325ABJ337MM-P			X5R	330 μ	±20	10	150	2.5±0.30	R
AMK325ABJ157MM-P			X5R	150 μ	±20	10	150	2.5±0.30	R
AMK325ABJ227MM-P		4	X5R	220 μ	±20	10	150	2.5±0.30	R
AMK325ABJ337MM-P			X5R	330 μ	±20	10	150	2.5±0.30	R

【温度特性 BJ : B/X5R】厚度 1.9mm (Y,N)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^{※3} [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
UMK325 BJ475□N-T		50	X5R	4.7 μ	±10, ±20	10	150	1.9±0.20	R
GMK325 BJ225□N-T			B X5R	2.2 μ	±10, ±20	3.5	200	1.9±0.20	R
GMK325 BJ475□N-T		35	X5R	4.7 μ	±10, ±20	10	150	1.9±0.20	R
GMK325 BJ106□N-T			B X5R	10 μ	±10, ±20	5	150	1.9±0.20	R
TMK325 BJ335MN-T		25	B X5R ^{※1}	3.3 μ	±20	3.5	200	1.9±0.20	R
TMK325 BJ475□N-T			B X5R ^{※1}	4.7 μ	±10, ±20	3.5	200	1.9±0.20	R
TMK325 BJ106□N-T			X5R	10 μ	±10, ±20	5	200	1.9±0.20	R
EMK325 BJ475□N-T			B X5R ^{※1}	4.7 μ	±10, ±20	3.5	200	1.9±0.20	R
EMK325 BJ106□N-T		16	X5R	10 μ	±10, ±20	3.5	200	1.9±0.20	R
EMK325 BJ476MY-T			X5R	47 μ	±20	10	150	1.9±0.1/-0.2	R
LMK325 BJ226MY-T		10	B X5R	22 μ	±20	5	150	1.9±0.1/-0.2	R
LMK325 BJ106□N-T			X5R	10 μ	±10, ±20	3.5	200	1.9±0.20	R
JMK325 BJ226MY-T		6.3	B X5R	22 μ	±20	5	200	1.9±0.1/-0.2	R
JMK325 BJ107MY-T			X5R	100 μ	±20	10	150	1.9±0.1/-0.2	R
JMK325 BJ476MN-T			X5R	47 μ	±20	10	150	1.9±0.20	R

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【温度特性 BJ : B/X5R】厚度0.85mm (D)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
TMK325 BJ106□D-T		25	B	X5R	10 μ	±10, ±20	5	150	0.85±0.10	R
EMK325 BJ106□D-T		16	B	X5R	10 μ	±10, ±20	5	150	0.85±0.10	R
EMK325 BJ226MD-T			B	X5R	22 μ	±20	10	150	0.85±0.10	R
LMK325 BJ335□D-T		10	B	X5R	3.3 μ	±10, ±20	3.5	200	0.85±0.10	R
LMK325 BJ475□D-T			B	X5R	4.7 μ	±10, ±20	5	200	0.85±0.10	R
LMK325 BJ106□D-T			B	X5R	10 μ	±10, ±20	5	150	0.85±0.10	R

【温度特性 C6 : X6S】厚度 2.5mm (M)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
EMK325AC6476MM-P		16		X6S	47 μ	±20	10	150	2.5±0.30	R
LMK325AC6107MM-P		10		X6S	100 μ	±20	10	150	2.5±0.30	R
JMK325AC6107MM-P		6.3		X6S	100 μ	±20	10	150	2.5±0.30	R
AMK325AC6157MM-P				X6S	150 μ	±20	10	150	2.5±0.30	R
AMK325AC6227MM-P		4		X6S	220 μ	±20	10	150	2.5±0.30	R
AMK325AC6337MM-P				X6S	330 μ	±20	10	150	2.5±0.30	R
PMK325AC6337MM-P		2.5		X6S	330 μ	±20	10	150	2.5±0.30	R

【温度特性 C7 : X7S】厚度 2.5mm (M)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
JMK325AC7107MM-P		6.3		X7S	100 μ	±20	10	150	2.5±0.30	R

【温度特性 B7 : X7R】厚度 2.5mm (M)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
UMK325 B7475□M-P		50		X7R	4.7 μ	±10, ±20	5	150	2.5±0.20	R
UMK325AB7106□M-P				X7R	10 μ	±10, ±20	10	150	2.5±0.30	R
TMK325AB7106□M-P		25		X7R	10 μ	±10, ±20	10	150	2.5±0.30	R
TMK325 B7226□M-PR				X7R	22 μ	±10, ±20	10	150	2.5±0.20	R
EMK325 B7226□M-PR		16		X7R	22 μ	±10, ±20	10	150	2.5±0.20	R
LMK325 B7476□M-PR		10		X7R	4.7 μ	±10, ±20	10	150	2.5±0.20	R
JMK325 B7476□M-PR		6.3		X7R	4.7 μ	±10, ±20	10	200	2.5±0.20	R

【温度特性 B7 : X7R】厚度 1.9mm (N)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
UMK325 B7475□N-TR		50		X7R	4.7 μ	±10, ±20	10	150	1.9±0.20	R
TMK325 B7335□N-T		25		X7R	3.3 μ	±10, ±20	3.5	200	1.9±0.20	R
TMK325 B7475□N-T				X7R	4.7 μ	±10, ±20	3.5	150	1.9±0.20	R
TMK325 B7106□N-TR				X7R	10 μ	±10, ±20	10	150	1.9±0.20	R
EMK325 B7475□N-T		16		X7R	4.7 μ	±10, ±20	3.5	200	1.9±0.20	R
EMK325 B7106□N-T				X7R	10 μ	±10, ±20	3.5	150	1.9±0.20	R
LMK325 B7106□N-T		10		X7R	10 μ	±10, ±20	3.5	200	1.9±0.20	R

● 432型

【温度特性 BJ : X5R】厚度 2.5mm (M)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
AMK432 BJ477MM-T		4		X5R	470 μ	±20	10	150	2.5±0.20	R

【温度特性 C6 : X6S】厚度 2.5mm (M)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
PMK432 C6477MM-T		2.5		X6S	470 μ	±20	10	150	2.5±0.20	R

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型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差	Q值 (at 1MHz) (min)	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
UMK063 CG7R1[]T-F		50	CG	C0G	7.1 p	±0.1pF, ±0.25pF, ±0.5pF	542	200	0.3±0.03	R
UMK063 CG7R2[]T-F			CG	C0G	7.2 p	±0.1pF, ±0.25pF, ±0.5pF	544	200	0.3±0.03	R
UMK063 CG7R3[]T-F			CG	C0G	7.3 p	±0.1pF, ±0.25pF, ±0.5pF	546	200	0.3±0.03	R
UMK063 CG7R4[]T-F			CG	C0G	7.4 p	±0.1pF, ±0.25pF, ±0.5pF	548	200	0.3±0.03	R
UMK063 CG7R5[]T-F			CG	C0G	7.5 p	±0.1pF, ±0.25pF, ±0.5pF	550	200	0.3±0.03	R
UMK063 CG7R6[]T-F			CG	C0G	7.6 p	±0.1pF, ±0.25pF, ±0.5pF	552	200	0.3±0.03	R
UMK063 CG7R7[]T-F			CG	C0G	7.7 p	±0.1pF, ±0.25pF, ±0.5pF	554	200	0.3±0.03	R
UMK063 CG7R8[]T-F			CG	C0G	7.8 p	±0.1pF, ±0.25pF, ±0.5pF	556	200	0.3±0.03	R
UMK063 CG7R9[]T-F			CG	C0G	7.9 p	±0.1pF, ±0.25pF, ±0.5pF	558	200	0.3±0.03	R
UMK063 CG8R0[]T-F			CG	C0G	8 p	±0.1pF, ±0.25pF, ±0.5pF	560	200	0.3±0.03	R
UMK063 CG8R1[]T-F			CG	C0G	8.1 p	±0.1pF, ±0.25pF, ±0.5pF	562	200	0.3±0.03	R
UMK063 CG8R2[]T-F			CG	C0G	8.2 p	±0.1pF, ±0.25pF, ±0.5pF	564	200	0.3±0.03	R
UMK063 CG8R3[]T-F			CG	C0G	8.3 p	±0.1pF, ±0.25pF, ±0.5pF	566	200	0.3±0.03	R
UMK063 CG8R4[]T-F			CG	C0G	8.4 p	±0.1pF, ±0.25pF, ±0.5pF	568	200	0.3±0.03	R
UMK063 CG8R5[]T-F			CG	C0G	8.5 p	±0.1pF, ±0.25pF, ±0.5pF	570	200	0.3±0.03	R
UMK063 CG8R6[]T-F			CG	C0G	8.6 p	±0.1pF, ±0.25pF, ±0.5pF	572	200	0.3±0.03	R
UMK063 CG8R7[]T-F			CG	C0G	8.7 p	±0.1pF, ±0.25pF, ±0.5pF	574	200	0.3±0.03	R
UMK063 CG8R8[]T-F			CG	C0G	8.8 p	±0.1pF, ±0.25pF, ±0.5pF	576	200	0.3±0.03	R
UMK063 CG8R9[]T-F			CG	C0G	8.9 p	±0.1pF, ±0.25pF, ±0.5pF	578	200	0.3±0.03	R
UMK063 CG9R0[]T-F			CG	C0G	9 p	±0.1pF, ±0.25pF, ±0.5pF	580	200	0.3±0.03	R
UMK063 CG9R1[]T-F			CG	C0G	9.1 p	±0.1pF, ±0.25pF, ±0.5pF	582	200	0.3±0.03	R
UMK063 CG9R2[]T-F			CG	C0G	9.2 p	±0.1pF, ±0.25pF, ±0.5pF	584	200	0.3±0.03	R
UMK063 CG9R3[]T-F			CG	C0G	9.3 p	±0.1pF, ±0.25pF, ±0.5pF	586	200	0.3±0.03	R
UMK063 CG9R4[]T-F			CG	C0G	9.4 p	±0.1pF, ±0.25pF, ±0.5pF	588	200	0.3±0.03	R
UMK063 CG9R5[]T-F			CG	C0G	9.5 p	±0.1pF, ±0.25pF, ±0.5pF	590	200	0.3±0.03	R
UMK063 CG9R6[]T-F			CG	C0G	9.6 p	±0.1pF, ±0.25pF, ±0.5pF	592	200	0.3±0.03	R
UMK063 CG9R7[]T-F			CG	C0G	9.7 p	±0.1pF, ±0.25pF, ±0.5pF	594	200	0.3±0.03	R
UMK063 CG9R8[]T-F			CG	C0G	9.8 p	±0.1pF, ±0.25pF, ±0.5pF	596	200	0.3±0.03	R
UMK063 CG9R9[]T-F			CG	C0G	9.9 p	±0.1pF, ±0.25pF, ±0.5pF	598	200	0.3±0.03	R
UMK063 CG100DT-F			CG	C0G	10 p	±5%	600	200	0.3±0.03	R
UMK063 CG110JT-F			CG	C0G	11 p	±5%	620	200	0.3±0.03	R
UMK063 CG120JT-F			CG	C0G	12 p	±5%	640	200	0.3±0.03	R
UMK063 CG130JT-F			CG	C0G	13 p	±5%	660	200	0.3±0.03	R
UMK063 CG150JT-F			CG	C0G	15 p	±5%	700	200	0.3±0.03	R
UMK063 CG160JT-F			CG	C0G	16 p	±5%	720	200	0.3±0.03	R
UMK063 CG180JT-F			CG	C0G	18 p	±5%	760	200	0.3±0.03	R
UMK063 CG200JT-F			CG	C0G	20 p	±5%	800	200	0.3±0.03	R
UMK063 CG220JT-F			CG	C0G	22 p	±5%	840	200	0.3±0.03	R
UMK063 CG240JT-F			CG	C0G	24 p	±5%	880	200	0.3±0.03	R
UMK063 CG270JT-F			CG	C0G	27 p	±5%	940	200	0.3±0.03	R
UMK063 CG300JT-F			CG	C0G	30 p	±5%	1000	200	0.3±0.03	R
UMK063 CG330JT-F			CG	C0G	33 p	±5%	1000	200	0.3±0.03	R
UMK063 CG360JT-F			CG	C0G	36 p	±5%	1000	200	0.3±0.03	R
UMK063 CG390JT-F			CG	C0G	39 p	±5%	1000	200	0.3±0.03	R
UMK063 CG430JT-F			CG	C0G	43 p	±5%	1000	200	0.3±0.03	R
UMK063 CG470JT-F			CG	C0G	47 p	±5%	1000	200	0.3±0.03	R
UMK063 CG510JT-F			CG	C0G	51 p	±5%	1000	200	0.3±0.03	R
UMK063 CG560JT-F			CG	C0G	56 p	±5%	1000	200	0.3±0.03	R
UMK063 CG620JT-F			CG	C0G	62 p	±5%	1000	200	0.3±0.03	R
UMK063 CG680JT-F			CG	C0G	68 p	±5%	1000	200	0.3±0.03	R
UMK063 CG750JT-F		CG	C0G	75 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG820JT-F		CG	C0G	82 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG910JT-F		CG	C0G	91 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG101JT-F		CG	C0G	100 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG111JT-F		CG	C0G	110 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG121JT-F		CG	C0G	120 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG131JT-F		CG	C0G	130 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG151JT-F		CG	C0G	150 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG181JT-F		CG	C0G	180 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG201JT-F		CG	C0G	200 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG221JT-F		CG	C0G	220 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG241JT-F		CG	C0G	240 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG271JT-F		CG	C0G	270 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG301JT-F		CG	C0G	300 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG331JT-F		CG	C0G	330 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG361JT-F		CG	C0G	360 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG391JT-F		CG	C0G	390 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG431JT-F		CG	C0G	430 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG471JT-F		CG	C0G	470 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG511JT-F		CG	C0G	510 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG561JT-F		CG	C0G	560 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG621JT-F		CG	C0G	620 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG681JT-F		CG	C0G	680 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG751JT-F		CG	C0G	750 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG821JT-F		CG	C0G	820 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG911JT-F		CG	C0G	910 p	±5%	1000	200	0.3±0.03	R	
UMK063 CG102JT-F		CG	C0G	1000 p	±5%	1000	200	0.3±0.03	R	

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● 105型

【温度特性 CG : CG/C0G】厚度 0.5mm (V)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差	Q值 (at 1MHz) (min)	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
UMK105 CG0R5CV-F		50	CG	C0G	0.5 p	±0.25pF	410	200	0.5±0.05	R
UMK105 CG010CV-F			CG	C0G	1 p	±0.25pF	420	200	0.5±0.05	R
UMK105 CG1R5CV-F			CG	C0G	1.5 p	±0.25pF	430	200	0.5±0.05	R
UMK105 CG020CV-F			CG	C0G	2 p	±0.25pF	440	200	0.5±0.05	R
UMK105 CG030CV-F			CG	C0G	3 p	±0.25pF	460	200	0.5±0.05	R
UMK105 CG040CV-F			CG	C0G	4 p	±0.25pF	480	200	0.5±0.05	R
UMK105 CG050CV-F			CG	C0G	5 p	±0.25pF	500	200	0.5±0.05	R
UMK105 CG060DV-F			CG	C0G	6 p	±0.5pF	520	200	0.5±0.05	R
UMK105 CG070DV-F			CG	C0G	7 p	±0.5pF	540	200	0.5±0.05	R
UMK105 CG080DV-F			CG	C0G	8 p	±0.5pF	560	200	0.5±0.05	R
UMK105 CG090DV-F			CG	C0G	9 p	±0.5pF	580	200	0.5±0.05	R
UMK105 CG100DV-F			CG	C0G	10 p	±0.5pF	600	200	0.5±0.05	R
UMK105 CG120JV-F			CG	C0G	12 p	±5%	640	200	0.5±0.05	R
UMK105 CG150JV-F			CG	C0G	15 p	±5%	700	200	0.5±0.05	R
UMK105 CG180JV-F			CG	C0G	18 p	±5%	760	200	0.5±0.05	R
UMK105 CG220JV-F			CG	C0G	22 p	±5%	840	200	0.5±0.05	R
UMK105 CG270JV-F			CG	C0G	27 p	±5%	940	200	0.5±0.05	R
UMK105 CG330JV-F			CG	C0G	33 p	±5%	1000	200	0.5±0.05	R
UMK105 CG390JV-F			CG	C0G	39 p	±5%	1000	200	0.5±0.05	R
UMK105 CG470JV-F			CG	C0G	47 p	±5%	1000	200	0.5±0.05	R
UMK105 CG560JV-F			CG	C0G	56 p	±5%	1000	200	0.5±0.05	R
UMK105 CG680JV-F			CG	C0G	68 p	±5%	1000	200	0.5±0.05	R
UMK105 CG820JV-F			CG	C0G	82 p	±5%	1000	200	0.5±0.05	R
UMK105 CG101JV-F			CG	C0G	100 p	±5%	1000	200	0.5±0.05	R
UMK105 CG121JV-F			CG	C0G	120 p	±5%	1000	200	0.5±0.05	R
UMK105 CG151JV-F			CG	C0G	150 p	±5%	1000	200	0.5±0.05	R
UMK105 CG181JV-F			CG	C0G	180 p	±5%	1000	200	0.5±0.05	R
UMK105 CG221JV-F			CG	C0G	220 p	±5%	1000	200	0.5±0.05	R
UMK105 CG271JV-F			CG	C0G	270 p	±5%	1000	200	0.5±0.05	R
UMK105 CG331JV-F			CG	C0G	330 p	±5%	1000	200	0.5±0.05	R
UMK105 CG391JV-F			CG	C0G	390 p	±5%	1000	200	0.5±0.05	R
UMK105 CG471JV-F			CG	C0G	470 p	±5%	1000	200	0.5±0.05	R
UMK105 CG561JV-F			CG	C0G	560 p	±5%	1000	200	0.5±0.05	R
UMK105 CG681JV-F		CG	C0G	680 p	±5%	1000	200	0.5±0.05	R	
UMK105 CG821JV-F		CG	C0G	820 p	±5%	1000	200	0.5±0.05	R	
UMK105 CG102JV-F		CG	C0G	1000 p	±5%	1000	200	0.5±0.05	R	

【温度特性 UΔ : UΔ/U2Δ】厚度 0.5mm (V)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差	Q值 (at 1MHz) (min)	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
UMK105 UK0R5CV-F		50	UK	U2K	0.5 p	±0.25pF	410	200	0.5±0.05	R
UMK105 UK010CV-F			UK	U2K	1 p	±0.25pF	420	200	0.5±0.05	R
UMK105 UK1R5CV-F			UK	U2K	1.5 p	±0.25pF	430	200	0.5±0.05	R
UMK105 UK020CV-F			UK	U2K	2 p	±0.25pF	440	200	0.5±0.05	R
UMK105 UK030CV-F			UK	U2K	3 p	±0.25pF	460	200	0.5±0.05	R
UMK105 UJ040CV-F			UJ	U2J	4 p	±0.25pF	480	200	0.5±0.05	R
UMK105 UJ050CV-F			UJ	U2J	5 p	±0.25pF	500	200	0.5±0.05	R
UMK105 UJ060DV-F			UJ	U2J	6 p	±0.5pF	520	200	0.5±0.05	R
UMK105 UJ070DV-F			UJ	U2J	7 p	±0.5pF	540	200	0.5±0.05	R
UMK105 UJ080DV-F			UJ	U2J	8 p	±0.5pF	560	200	0.5±0.05	R
UMK105 UJ090DV-F			UJ	U2J	9 p	±0.5pF	580	200	0.5±0.05	R
UMK105 UJ100DV-F			UJ	U2J	10 p	±0.5pF	600	200	0.5±0.05	R
UMK105 UJ120JV-F			UJ	U2J	12 p	±5%	640	200	0.5±0.05	R
UMK105 UJ150JV-F			UJ	U2J	15 p	±5%	700	200	0.5±0.05	R
UMK105 UJ180JV-F			UJ	U2J	18 p	±5%	760	200	0.5±0.05	R
UMK105 UJ220JV-F			UJ	U2J	22 p	±5%	840	200	0.5±0.05	R
UMK105 UJ270JV-F			UJ	U2J	27 p	±5%	940	200	0.5±0.05	R
UMK105 UJ330JV-F			UJ	U2J	33 p	±5%	1000	200	0.5±0.05	R
UMK105 UJ390JV-F			UJ	U2J	39 p	±5%	1000	200	0.5±0.05	R
UMK105 UJ470JV-F			UJ	U2J	47 p	±5%	1000	200	0.5±0.05	R
UMK105 UJ560JV-F			UJ	U2J	56 p	±5%	1000	200	0.5±0.05	R
UMK105 UJ680JV-F			UJ	U2J	68 p	±5%	1000	200	0.5±0.05	R
UMK105 UJ820JV-F			UJ	U2J	82 p	±5%	1000	200	0.5±0.05	R
UMK105 UJ101JV-F			UJ	U2J	100 p	±5%	1000	200	0.5±0.05	R
UMK105 UJ121JV-F			UJ	U2J	120 p	±5%	1000	200	0.5±0.05	R
UMK105 UJ151JV-F			UJ	U2J	150 p	±5%	1000	200	0.5±0.05	R
UMK105 UJ181JV-F			UJ	U2J	180 p	±5%	1000	200	0.5±0.05	R
UMK105 UJ221JV-F			UJ	U2J	220 p	±5%	1000	200	0.5±0.05	R
UMK105 UJ271JV-F			UJ	U2J	270 p	±5%	1000	200	0.5±0.05	R
UMK105 UJ331JV-F			UJ	U2J	330 p	±5%	1000	200	0.5±0.05	R

【温度特性 SL】厚度 0.5mm (V)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差	Q值 (at 1MHz) (min)	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
UMK105 SL121JV-F		50	SL		120 p	±5%	1000	200	0.5±0.05	R
UMK105 SL151JV-F			SL		150 p	±5%	1000	200	0.5±0.05	R
UMK105 SL181JV-F			SL		180 p	±5%	1000	200	0.5±0.05	R
UMK105 SL221JV-F			SL		220 p	±5%	1000	200	0.5±0.05	R
UMK105 SL271JV-F			SL		270 p	±5%	1000	200	0.5±0.05	R
UMK105 SL331JV-F			SL		330 p	±5%	1000	200	0.5±0.05	R

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型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差	Q值 (at 1GHz) (min)	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
TVS042 CG8R6□C-W		25	CG	C0G	8.6 p	±0.1pF, ±0.25pF, ±0.5pF	50	200	0.2±0.02	R
TVS042 CG8R7□C-W			CG	C0G	8.7 p	±0.1pF, ±0.25pF, ±0.5pF	50	200	0.2±0.02	R
TVS042 CG8R8□C-W			CG	C0G	8.8 p	±0.1pF, ±0.25pF, ±0.5pF	50	200	0.2±0.02	R
TVS042 CG8R9□C-W			CG	C0G	8.9 p	±0.1pF, ±0.25pF, ±0.5pF	50	200	0.2±0.02	R
TVS042 CG090□C-W			CG	C0G	9 p	±0.1pF, ±0.25pF, ±0.5pF	50	200	0.2±0.02	R
TVS042 CG9R1□C-W			CG	C0G	9.1 p	±0.1pF, ±0.25pF, ±0.5pF	45	200	0.2±0.02	R
TVS042 CG9R2□C-W			CG	C0G	9.2 p	±0.1pF, ±0.25pF, ±0.5pF	45	200	0.2±0.02	R
TVS042 CG9R3□C-W			CG	C0G	9.3 p	±0.1pF, ±0.25pF, ±0.5pF	45	200	0.2±0.02	R
TVS042 CG9R4□C-W			CG	C0G	9.4 p	±0.1pF, ±0.25pF, ±0.5pF	45	200	0.2±0.02	R
TVS042 CG9R5□C-W			CG	C0G	9.5 p	±0.1pF, ±0.25pF, ±0.5pF	45	200	0.2±0.02	R
TVS042 CG9R6□C-W			CG	C0G	9.6 p	±0.1pF, ±0.25pF, ±0.5pF	45	200	0.2±0.02	R
TVS042 CG9R7□C-W			CG	C0G	9.7 p	±0.1pF, ±0.25pF, ±0.5pF	45	200	0.2±0.02	R
TVS042 CG9R8□C-W			CG	C0G	9.8 p	±0.1pF, ±0.25pF, ±0.5pF	45	200	0.2±0.02	R
TVS042 CG9R9□C-W			CG	C0G	9.9 p	±0.1pF, ±0.25pF, ±0.5pF	45	200	0.2±0.02	R
TVS042 CG100□C-W			CG	C0G	10 p	±2%, ±5%	45	200	0.2±0.02	R
TVS042 CG110JC-W			CG	C0G	11 p	±5%	40	200	0.2±0.02	R
TVS042 CG120JC-W			CG	C0G	12 p	±5%	40	200	0.2±0.02	R
TVS042 CG130JC-W			CG	C0G	13 p	±5%	40	200	0.2±0.02	R
TVS042 CG150JC-W			CG	C0G	15 p	±5%	40	200	0.2±0.02	R
TVS042 CG160JC-W			CG	C0G	16 p	±5%	40	200	0.2±0.02	R
TVS042 CG180JC-W			CG	C0G	18 p	±5%	40	200	0.2±0.02	R
TVS042 CG220JC-W			CG	C0G	22 p	±5%	30	200	0.2±0.02	R

● 105型

【温度特性 CG : CG/C0G】厚度 0.5mm (W)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差	Q值 (at 1GHz) (min)	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
EVK105 CG0R3BW-F		16	CG	C0G	0.3 p	±0.1pF	300	200	0.5±0.05	R
EVK105 CG0R4BW-F			CG	C0G	0.4 p	±0.1pF	300	200	0.5±0.05	R
EVK105 CG0R5BW-F			CG	C0G	0.5 p	±0.1pF	300	200	0.5±0.05	R
EVK105 CG0R6BW-F			CG	C0G	0.6 p	±0.1pF	300	200	0.5±0.05	R
EVK105 CG0R7BW-F			CG	C0G	0.7 p	±0.1pF	300	200	0.5±0.05	R
EVK105 CG0R8BW-F			CG	C0G	0.8 p	±0.1pF	300	200	0.5±0.05	R
EVK105 CG0R9BW-F			CG	C0G	0.9 p	±0.1pF	300	200	0.5±0.05	R
EVK105 CG010BW-F			CG	C0G	1 p	±0.1pF	300	200	0.5±0.05	R
EVK105 CG1R1BW-F			CG	C0G	1.1 p	±0.1pF	280	200	0.5±0.05	R
EVK105 CG1R2BW-F			CG	C0G	1.2 p	±0.1pF	270	200	0.5±0.05	R
EVK105 CG1R3BW-F			CG	C0G	1.3 p	±0.1pF	260	200	0.5±0.05	R
EVK105 CG1R5BW-F			CG	C0G	1.5 p	±0.1pF	240	200	0.5±0.05	R
EVK105 CG1R6BW-F			CG	C0G	1.6 p	±0.1pF	230	200	0.5±0.05	R
EVK105 CG1R8BW-F			CG	C0G	1.8 p	±0.1pF	210	200	0.5±0.05	R
EVK105 CG020BW-F			CG	C0G	2 p	±0.1pF	190	200	0.5±0.05	R
EVK105 CG2R2JW-F			CG	C0G	2.2 p	±5%	180	200	0.5±0.05	R
EVK105 CG2R4JW-F			CG	C0G	2.4 p	±5%	170	200	0.5±0.05	R
EVK105 CG2R7JW-F			CG	C0G	2.7 p	±5%	150	200	0.5±0.05	R
EVK105 CG030JW-F			CG	C0G	3 p	±5%	130	200	0.5±0.05	R
EVK105 CG3R3JW-F			CG	C0G	3.3 p	±5%	120	200	0.5±0.05	R
EVK105 CG3R6JW-F			CG	C0G	3.6 p	±5%	110	200	0.5±0.05	R
EVK105 CG3R9JW-F			CG	C0G	3.9 p	±5%	99	200	0.5±0.05	R
EVK105 CG4R3JW-F			CG	C0G	4.3 p	±5%	84	200	0.5±0.05	R
EVK105 CG4R7JW-F			CG	C0G	4.7 p	±5%	84	200	0.5±0.05	R
EVK105 CG5R1JW-F			CG	C0G	5.1 p	±5%	84	200	0.5±0.05	R

【温度特性 CG : CG/C0G】厚度 0.5mm (W)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差	Q值 (at 1GHz) (min)	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
UVK105 CG0R3BW-F		50	CG	C0G	0.3 p	±0.1pF	300	200	0.5±0.05	R
UVK105 CG0R4BW-F			CG	C0G	0.4 p	±0.1pF	300	200	0.5±0.05	R
UVK105 CG0R5BW-F			CG	C0G	0.5 p	±0.1pF	300	200	0.5±0.05	R
UVK105 CG0R6BW-F			CG	C0G	0.6 p	±0.1pF	300	200	0.5±0.05	R
UVK105 CG0R7BW-F			CG	C0G	0.7 p	±0.1pF	300	200	0.5±0.05	R
UVK105 CG0R8BW-F			CG	C0G	0.8 p	±0.1pF	300	200	0.5±0.05	R
UVK105 CG0R9BW-F			CG	C0G	0.9 p	±0.1pF	300	200	0.5±0.05	R
UVK105 CG010BW-F			CG	C0G	1 p	±0.1pF	300	200	0.5±0.05	R
UVK105 CG1R1BW-F			CG	C0G	1.1 p	±0.1pF	280	200	0.5±0.05	R
UVK105 CG1R2BW-F			CG	C0G	1.2 p	±0.1pF	270	200	0.5±0.05	R
UVK105 CG1R3BW-F			CG	C0G	1.3 p	±0.1pF	260	200	0.5±0.05	R
UVK105 CG1R5BW-F			CG	C0G	1.5 p	±0.1pF	240	200	0.5±0.05	R
UVK105 CG1R6BW-F			CG	C0G	1.6 p	±0.1pF	230	200	0.5±0.05	R
UVK105 CG1R8BW-F			CG	C0G	1.8 p	±0.1pF	210	200	0.5±0.05	R
UVK105 CG020BW-F			CG	C0G	2 p	±0.1pF	190	200	0.5±0.05	R
UVK105 CG2R2JW-F			CG	C0G	2.2 p	±5%	180	200	0.5±0.05	R
UVK105 CG2R4JW-F			CG	C0G	2.4 p	±5%	170	200	0.5±0.05	R
UVK105 CG2R7JW-F			CG	C0G	2.7 p	±5%	150	200	0.5±0.05	R
UVK105 CG030JW-F			CG	C0G	3 p	±5%	130	200	0.5±0.05	R
UVK105 CG3R3JW-F			CG	C0G	3.3 p	±5%	120	200	0.5±0.05	R
UVK105 CG3R6JW-F			CG	C0G	3.6 p	±5%	110	200	0.5±0.05	R
UVK105 CG3R9JW-F			CG	C0G	3.9 p	±5%	99	200	0.5±0.05	R
UVK105 CG4R3JW-F			CG	C0G	4.3 p	±5%	84	200	0.5±0.05	R
UVK105 CG4R7JW-F			CG	C0G	4.7 p	±5%	84	200	0.5±0.05	R
UVK105 CG5R1JW-F			CG	C0G	5.1 p	±5%	84	200	0.5±0.05	R

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超低失真多层陶瓷电容器

● 105型

【温度特性 SD : Standard】厚度 0.5mm (V)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^③ [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
UMK105 SD391KV-F		50	Standard Type	390 p	±10	0.1	200	0.5±0.05	R
UMK105 SD471KV-F				470 p	±10	0.1	200	0.5±0.05	R
UMK105 SD561KV-F		560 p		±10	0.1	200	0.5±0.05	R	
TMK105 SD681KV-F		680 p		±10	0.1	200	0.5±0.05	R	
TMK105 SD821KV-F		820 p		±10	0.1	200	0.5±0.05	R	
TMK105 SD102KV-F		1000 p		±10	0.1	200	0.5±0.05	R	
TMK105 SD122KV-F		1200 p		±10	0.1	200	0.5±0.05	R	
EMK105 SD152KV-F		1500 p		±10	0.1	200	0.5±0.05	R	
EMK105 SD182KV-F		1800 p		±10	0.1	200	0.5±0.05	R	
EMK105 SD222KV-F		2200 p		±10	0.1	200	0.5±0.05	R	
EMK105 SD272KV-F		2700 p	±10	0.1	200	0.5±0.05	R		
LMK105 SD332KV-F		3300 p	±10	0.1	200	0.5±0.05	R		
LMK105 SD392KV-F		3900 p	±10	0.1	200	0.5±0.05	R		
LMK105 SD472KV-F		4700 p	±10	0.1	200	0.5±0.05	R		

【温度特性 SD : Standard】厚度 0.3mm (P)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^③ [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
LMK105 SD152KP-F		10	Standard Type	1500 p	±10	0.1	200	0.3±0.03	R
JMK105 SD272KP-F		6.3		2700 p	±10	0.1	200	0.3±0.03	R

● 107型

【温度特性 SD : Standard】厚度 0.8mm (A)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^③ [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
UMK107 SD102KA-T		50	Standard Type	1000 p	±10	0.1	200	0.8±0.10	R
UMK107 SD122KA-T				1200 p	±10	0.1	200	0.8±0.10	R
UMK107 SD152KA-T				1500 p	±10	0.1	200	0.8±0.10	R
UMK107 SD182KA-T				1800 p	±10	0.1	200	0.8±0.10	R
UMK107 SD222KA-T				2200 p	±10	0.1	200	0.8±0.10	R
UMK107 SD272KA-T				2700 p	±10	0.1	200	0.8±0.10	R
UMK107 SD332KA-T				3300 p	±10	0.1	200	0.8±0.10	R
TMK107 SD392KA-T				3900 p	±10	0.1	200	0.8±0.10	R
TMK107 SD472KA-T				4700 p	±10	0.1	200	0.8±0.10	R
EMK107 SD562KA-T				5600 p	±10	0.1	200	0.8±0.10	R
EMK107 SD682KA-T		16	Standard Type	6800 p	±10	0.1	200	0.8±0.10	R
EMK107 SD822KA-T				8200 p	±10	0.1	200	0.8±0.10	R
EMK107 SD103KA-T		10	Standard Type	0.01 μ	±10	0.1	200	0.8±0.10	R
LMK107 SD123KA-T				0.012 μ	±10	0.1	200	0.8±0.10	R
LMK107 SD153KA-T				0.015 μ	±10	0.1	200	0.8±0.10	R
LMK107 SD183KA-T				0.018 μ	±10	0.1	200	0.8±0.10	R
LMK107 SD223KA-T				0.022 μ	±10	0.1	200	0.8±0.10	R

● 212型

【温度特性 SD : Standard】厚度 1.25mm (G)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^③ [mm]	焊接方式 R: 回流焊 W: 波峰焊	
							额定电压 x %			
GMK212 SD183KG-T		35	Standard Type	0.018 μ	±10	0.1	200	1.25±0.10	R	
GMK212 SD223KG-T				0.022 μ	±10	0.1	200	1.25±0.10	R	
GMK212 SD273KG-T				0.027 μ	±10	0.1	200	1.25±0.10	R	
LMK212 SD683KG-T		10		Standard Type	0.068 μ	±10	0.1	200	1.25±0.10	R
LMK212 SD823KG-T					0.082 μ	±10	0.1	200	1.25±0.10	R
LMK212 SD104KG-T					0.1 μ	±10	0.1	200	1.25±0.10	R

【温度特性 SD : Standard】厚度 0.85mm (D)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^③ [mm]	焊接方式 R: 回流焊 W: 波峰焊		
							额定电压 x %				
UMK212 SD392KD-T		50	Standard Type	3900 p	±10	0.1	200	0.85±0.10	R		
UMK212 SD472KD-T				4700 p	±10	0.1	200	0.85±0.10	R		
UMK212 SD562KD-T				5600 p	±10	0.1	200	0.85±0.10	R		
UMK212 SD682KD-T				6800 p	±10	0.1	200	0.85±0.10	R		
UMK212 SD822KD-T				8200 p	±10	0.1	200	0.85±0.10	R		
UMK212 SD103KD-T				0.01 μ	±10	0.1	200	0.85±0.10	R		
GMK212 SD123KD-T				35	Standard Type	0.012 μ	±10	0.1	200	0.85±0.10	R
GMK212 SD153KD-T						0.015 μ	±10	0.1	200	0.85±0.10	R
EMK212 SD333KD-T						0.033 μ	±10	0.1	200	0.85±0.10	R
LMK212 SD473KD-T				10	Standard Type	0.047 μ	±10	0.1	200	0.85±0.10	R

● 316型

【温度特性 SD : Standard】厚度 1.6mm (L)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ^③ [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
TMK316 SD823KL-T		25	Standard Type	0.082 μ	±10	0.1	200	1.6±0.20	R
TMK316 SD104KL-T				0.1 μ	±10	0.1	200	1.6±0.20	R

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【温度特性 SD : Standard】厚度 1.15mm (F)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
GMK316 SD333KF-T		35	Standard Type	0.033 μ	±10	0.1	200	1.15±0.10	R
GMK316 SD393KF-T				0.039 μ	±10	0.1	200	1.15±0.10	R
TMK316 SD473KF-T				0.047 μ	±10	0.1	200	1.15±0.10	R
TMK316 SD563KF-T		25		0.056 μ	±10	0.1	200	1.15±0.10	R
TMK316 SD683KF-T				0.068 μ	±10	0.1	200	1.15±0.10	R

低失真大容量多层陶瓷电容器 (CF-LD)

● 107型

【温度特性 LD : X5R】厚度 0.8mm (A)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
UMK107BLD224□A-T		50	X5R	0.22 μ	±10, ±20	10	150	0.8+0.20/-0	R
TMK107BLD474□A-T		25	X5R	0.47 μ	±10, ±20	10	150	0.8+0.20/-0	R
TMK107BLD105□A-T			X5R	1 μ	±10, ±20	10	150	0.8+0.20/-0	R

● 212型

【温度特性 LD : X5R】厚度 1.25mm (G)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
GMK212 LD105□G-T		35	X5R	1 μ	±10, ±20	10	150	1.25±0.10	R
GMK212BLD225□G-T			X5R	2.2 μ	±10, ±20	10	150	1.25+0.20/-0	R

● 316型

【温度特性 LD : X5R】厚度 1.6mm (L)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
UMK316 LD105□L-T		50	X5R	1 μ	±10, ±20	10	150	1.6±0.20	R
GMK316BLD475□L-T		35	X5R	4.7 μ	±10, ±20	10	150	1.6±0.30	R
TMK316BLD106□L-T		25	X5R	10 μ	±10, ±20	10	150	1.6±0.30	R

● 325型

【温度特性 LD : X5R】厚度 1.9mm (N)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
UMK325 LD105□N-T		50	X5R	1 μ	±10, ±20	10	200	1.9±0.20	R

【温度特性 LD : X5R】厚度 2.5mm (M)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
UMK325 LD155□M-P		50	X5R	1.5 μ	±10, ±20	5	150	2.5±0.20	R
UMK325 LD475□M-P			X5R	4.7 μ	±10, ±20	10	200	2.5±0.20	R

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中高耐压多层陶瓷电容器

● 105型

【温度特性 B7 : X7R】厚度 0.5mm (V)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ⁴³ [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK105 B7221□V-F		100		X7R	220 p	±10, ±20	2.5	200	0.5±0.05	R
HMK105 B7331□V-F				X7R	330 p	±10, ±20	2.5	200	0.5±0.05	R
HMK105 B7471□V-F				X7R	470 p	±10, ±20	2.5	200	0.5±0.05	R
HMK105 B7681□V-F				X7R	680 p	±10, ±20	2.5	200	0.5±0.05	R
HMK105 B7102□V-F				X7R	1000 p	±10, ±20	2.5	200	0.5±0.05	R
HMK105 B7152□V-F				X7R	1500 p	±10, ±20	2.5	200	0.5±0.05	R
HMK105 B7222□V-F				X7R	2200 p	±10, ±20	2.5	200	0.5±0.05	R
HMK105 B7332□V-F				X7R	3300 p	±10, ±20	2.5	200	0.5±0.05	R
HMK105 B7472□V-F				X7R	4700 p	±10, ±20	2.5	200	0.5±0.05	R

【温度特性 CG : CG/C0G】厚度 0.5mm (V)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	Q (at 1MHz) min	高温负载	厚度 ⁴³ [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK105 CG080DV-F		100	CG	C0G	8 p	±0.5pF	560	200	0.5±0.05	R
HMK105 CG090DV-F			CG	C0G	9 p	±0.5pF	580	200	0.5±0.05	R
HMK105 CG100DV-F			CG	C0G	10 p	±0.5pF	600	200	0.5±0.05	R
HMK105 CG120JV-F			CG	C0G	12 p	±5%	640	200	0.5±0.05	R
HMK105 CG150JV-F			CG	C0G	15 p	±5%	700	200	0.5±0.05	R
HMK105 CG180JV-F			CG	C0G	18 p	±5%	760	200	0.5±0.05	R
HMK105 CG220JV-F			CG	C0G	22 p	±5%	840	200	0.5±0.05	R
HMK105 CG240JV-F			CG	C0G	24 p	±5%	880	200	0.5±0.05	R
HMK105 CG270JV-F			CG	C0G	27 p	±5%	940	200	0.5±0.05	R
HMK105 CG330JV-F			CG	C0G	33 p	±5%	1000	200	0.5±0.05	R
HMK105 CG390JV-F			CG	C0G	39 p	±5%	1000	200	0.5±0.05	R
HMK105 CG470JV-F			CG	C0G	47 p	±5%	1000	200	0.5±0.05	R
HMK105 CG560JV-F			CG	C0G	56 p	±5%	1000	200	0.5±0.05	R
HMK105 CG680JV-F			CG	C0G	68 p	±5%	1000	200	0.5±0.05	R
HMK105 CG820JV-F			CG	C0G	82 p	±5%	1000	200	0.5±0.05	R
HMK105 CG101JV-F			CG	C0G	100 p	±5%	1000	200	0.5±0.05	R

● 107型

【温度特性 BJ : B/X5R】厚度 0.8mm (A)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ⁴³ [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK107 BJ102□A-T		100	B	X5R ⁴¹	1000 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 BJ152□A-T			B	X5R ⁴¹	1500 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 BJ222□A-T			B	X5R ⁴¹	2200 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 BJ332□A-T			B	X5R ⁴¹	3300 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 BJ472□A-T			B	X5R ⁴¹	4700 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 BJ682□A-T			B	X5R ⁴¹	6800 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 BJ103□A-T			B	X5R ⁴¹	0.01 μ	±10, ±20	3.5	200	0.8±0.10	R
HMK107 BJ153□A-T			B	X5R ⁴¹	0.015 μ	±10, ±20	3.5	200	0.8±0.10	R
HMK107 BJ223□A-T			B	X5R ⁴¹	0.022 μ	±10, ±20	3.5	200	0.8±0.10	R
HMK107 BJ333□A-T			B	X5R ⁴¹	0.033 μ	±10, ±20	3.5	200	0.8±0.10	R
HMK107 BJ473□A-T			B	X5R ⁴¹	0.047 μ	±10, ±20	3.5	200	0.8±0.10	R
HMK107 BJ104□A-T			B	X5R ⁴¹	0.1 μ	±10, ±20	3.5	200	0.8±0.10	R
HMK107 BJ224□A-TE			B	X5R ⁴¹	0.22 μ	±10, ±20	3.5	150	0.8±0.10	R

【温度特性 C7 : X7S】厚度 0.8mm (A)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ⁴³ [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK107 C7224□A-TE		100		X7S	0.22 μ	±10, ±20	3.5	150	0.8±0.10	R

【温度特性 B7 : X7R】厚度 0.8mm (A)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ⁴³ [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK107 B7102□A-T		100		X7R	1000 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7152□A-T				X7R	1500 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7222□A-T				X7R	2200 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7332□A-T				X7R	3300 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7472□A-T				X7R	4700 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7682□A-T				X7R	6800 p	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7103□A-T				X7R	0.01 μ	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7153□A-T				X7R	0.015 μ	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7223□A-T				X7R	0.022 μ	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7333□A-T				X7R	0.033 μ	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7473□A-T				X7R	0.047 μ	±10, ±20	3.5	200	0.8±0.10	R
HMK107 B7104□A-T				X7R	0.1 μ	±10, ±20	3.5	200	0.8±0.10	R

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【温度特性 SD : Standard】厚度 0.8mm (A)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK107 SD101KA-T		100	Standard Type		100 p	±10	0.1	200	0.8±0.10	R
HMK107 SD121KA-T					120 p	±10	0.1	200	0.8±0.10	R
HMK107 SD151KA-T					150 p	±10	0.1	200	0.8±0.10	R
HMK107 SD181KA-T					180 p	±10	0.1	200	0.8±0.10	R
HMK107 SD221KA-T					220 p	±10	0.1	200	0.8±0.10	R
HMK107 SD271KA-T					270 p	±10	0.1	200	0.8±0.10	R
HMK107 SD331KA-T					330 p	±10	0.1	200	0.8±0.10	R
HMK107 SD391KA-T					390 p	±10	0.1	200	0.8±0.10	R
HMK107 SD471KA-T					470 p	±10	0.1	200	0.8±0.10	R
HMK107 SD561KA-T					560 p	±10	0.1	200	0.8±0.10	R
HMK107 SD681KA-T					680 p	±10	0.1	200	0.8±0.10	R
HMK107 SD821KA-T					820 p	±10	0.1	200	0.8±0.10	R
HMK107 SD102KA-T					1000 p	±10	0.1	200	0.8±0.10	R

● 212型

【温度特性 BJ : B/X5R】厚度 1.25mm (G)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK212 BJ103□G-T		100	B	X5R ⁺¹	0.01 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 BJ153□G-T			B	X5R ⁺¹	0.015 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 BJ223□G-T			B	X5R ⁺¹	0.022 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 BJ333□G-T			B	X5R ⁺¹	0.033 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 BJ473□G-T			B	X5R ⁺¹	0.047 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 BJ683□G-T			B	X5R ⁺¹	0.068 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 BJ104□G-T			B	X5R ⁺¹	0.1 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 BJ224□G-T			B	X5R ⁺¹	0.22 μ	±10, ±20	3.5	200	1.25±0.10	R
HMK212 BJ474□G-TE			B	X5R ⁺¹	0.47 μ	±10, ±20	3.5	150	1.25±0.10	R
HMK212 BBJ105□G-TE			B	X5R ⁺¹	1 μ	±10, ±20	3.5	150	1.25+0.20/-0	R
QMK212 BJ472□G-T			B	X5R ⁺¹	4700 p	±10, ±20	2.5	150	1.25±0.10	R
QMK212 BJ682□G-T			B	X5R ⁺¹	6800 p	±10, ±20	2.5	150	1.25±0.10	R
QMK212 BJ103□G-T			B	X5R ⁺¹	0.01 μ	±10, ±20	2.5	150	1.25±0.10	R
QMK212 BJ153□G-T			B	X5R ⁺¹	0.015 μ	±10, ±20	2.5	150	1.25±0.10	R
QMK212 BJ223□G-T			B	X5R ⁺¹	0.022 μ	±10, ±20	2.5	150	1.25±0.10	R

【温度特性 BJ : B/X5R】厚度 0.85mm (D)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
QMK212 BJ102□D-T		250	B	X5R ⁺¹	1000 p	±10, ±20	2.5	150	0.85±0.10	R
QMK212 BJ152□D-T			B	X5R ⁺¹	1500 p	±10, ±20	2.5	150	0.85±0.10	R
QMK212 BJ222□D-T			B	X5R ⁺¹	2200 p	±10, ±20	2.5	150	0.85±0.10	R
QMK212 BJ332□D-T			B	X5R ⁺¹	3300 p	±10, ±20	2.5	150	0.85±0.10	R

【温度特性 C7 : X7S】厚度 1.25mm (G)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK212 C7474□G-TE		100		X7S	0.47 μ	±10, ±20	3.5	150	1.25±0.10	R
HMK212 BC7105□G-TE		100		X7S	1 μ	±10, ±20	3.5	150	1.25+0.20/-0	R

【温度特性 B7 : X7R】厚度 1.25mm (G)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊		
								额定电压 x %				
HMK212 B7103□G-T		100		X7R	0.01 μ	±10, ±20	3.5	200	1.25±0.10	R		
HMK212 B7153□G-T					X7R	0.015 μ	±10, ±20	3.5	200	1.25±0.10	R	
HMK212 B7223□G-T					X7R	0.022 μ	±10, ±20	3.5	200	1.25±0.10	R	
HMK212 B7333□G-T					X7R	0.033 μ	±10, ±20	3.5	200	1.25±0.10	R	
HMK212 B7473□G-T					X7R	0.047 μ	±10, ±20	3.5	200	1.25±0.10	R	
HMK212 B7683□G-T					X7R	0.068 μ	±10, ±20	3.5	200	1.25±0.10	R	
HMK212 B7104□G-T					X7R	0.1 μ	±10, ±20	3.5	200	1.25±0.10	R	
HMK212 B7224□G-T					X7R	0.22 μ	±10, ±20	3.5	200	1.25±0.10	R	
QMK212 B7472□G-T					X7R	4700 p	±10, ±20	2.5	150	1.25±0.10	R	
QMK212 B7682□G-T					X7R	6800 p	±10, ±20	2.5	150	1.25±0.10	R	
QMK212 B7103□G-T			250		X7R	0.01 μ	±10, ±20	2.5	150	1.25±0.10	R	
QMK212 B7153□G-T						X7R	0.015 μ	±10, ±20	2.5	150	1.25±0.10	R
QMK212 B7223□G-T						X7R	0.022 μ	±10, ±20	2.5	150	1.25±0.10	R
QMK212 B7332□G-T						X7R	0.033 μ	±10, ±20	2.5	150	1.25±0.10	R

【温度特性 B7 : X7R】厚度 0.85mm (D)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊	
								额定电压 x %			
QMK212 B7102□D-T		250		X7R	1000 p	±10, ±20	2.5	150	0.85±0.10	R	
QMK212 B7152□D-T					X7R	1500 p	±10, ±20	2.5	150	0.85±0.10	R
QMK212 B7222□D-T					X7R	2200 p	±10, ±20	2.5	150	0.85±0.10	R
QMK212 B7332□D-T					X7R	3300 p	±10, ±20	2.5	150	0.85±0.10	R

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【温度特性 SD : Standard】厚度 0.85mm (D)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ⁴³ [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
HMK212 SD222KD-T		100	Standard Type	2200 p	±10	0.1	200	0.85±0.10	R
HMK212 SD472KD-T				4700 p	±10	0.1	200	0.85±0.10	R
QMK212 SD101KD-T				100 p	±10	0.1	150	0.85±0.10	R
QMK212 SD121KD-T				120 p	±10	0.1	150	0.85±0.10	R
QMK212 SD151KD-T				150 p	±10	0.1	150	0.85±0.10	R
QMK212 SD181KD-T				180 p	±10	0.1	150	0.85±0.10	R
QMK212 SD221KD-T				220 p	±10	0.1	150	0.85±0.10	R
QMK212 SD331KD-T				330 p	±10	0.1	150	0.85±0.10	R
QMK212 SD391KD-T				390 p	±10	0.1	150	0.85±0.10	R
QMK212 SD471KD-T				470 p	±10	0.1	150	0.85±0.10	R
QMK212 SD561KD-T				560 p	±10	0.1	150	0.85±0.10	R
QMK212 SD681KD-T				680 p	±10	0.1	150	0.85±0.10	R
QMK212 SD821KD-T				820 p	±10	0.1	150	0.85±0.10	R
QMK212 SD102KD-T				1000 p	±10	0.1	150	0.85±0.10	R

【温度特性 SD : Standard】厚度 1.25mm (G)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ⁴³ [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
HMK212 SD392KG-T		100	Standard Type	3900 p	±10	0.1	200	1.25±0.10	R

● 316型

【温度特性 BJ : B/X5R】厚度 1.6mm (L)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ⁴³ [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
HMK316 BJ473□L-T		100	Standard Type	B X5R ⁺ 0.047 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 BJ683□L-T				B X5R ⁺ 0.068 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 BJ104□L-T				B X5R ⁺ 0.1 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 BJ154□L-T				B X5R ⁺ 0.15 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 BJ224□L-T				B X5R ⁺ 0.22 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 BJ334□L-T				B X5R ⁺ 0.33 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 BJ474□L-T				B X5R ⁺ 0.47 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 BJ105□L-T				B X5R ⁺ 1 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316ABJ225□L-TE				B X5R ⁺ 2.2 μ	±10, ±20	3.5	150	1.6±0.20	R
QMK316 BJ333□L-T				B X5R ⁺ 0.033 μ	±10, ±20	2.5	150	1.6±0.20	R
QMK316 BJ473□L-T				B X5R ⁺ 0.047 μ	±10, ±20	2.5	150	1.6±0.20	R
QMK316 BJ683□L-T				B X5R ⁺ 0.068 μ	±10, ±20	2.5	150	1.6±0.20	R
QMK316 BJ104□L-T				B X5R ⁺ 0.1 μ	±10, ±20	2.5	150	1.6±0.20	R
SMK316 BJ153□L-T				B X5R ⁺ 0.015 μ	±10, ±20	2.5	120	1.6±0.20	R
SMK316 BJ223□L-T		B X5R ⁺ 0.022 μ	±10, ±20	2.5	120	1.6±0.20	R		

【温度特性 BJ : B/X5R】厚度 1.15mm (F)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ⁴³ [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
SMK316 BJ102□F-T		630	Standard Type	B X5R ⁺ 1000 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 BJ152□F-T				B X5R ⁺ 1500 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 BJ222□F-T				B X5R ⁺ 2200 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 BJ332□F-T				B X5R ⁺ 3300 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 BJ472□F-T				B X5R ⁺ 4700 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 BJ682□F-T				B X5R ⁺ 6800 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 BJ103□F-T				B X5R ⁺ 0.01 μ	±10, ±20	2.5	120	1.15±0.10	R

【温度特性 C7 : X7S】厚度 1.6mm (L)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ⁴³ [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
HMK316AC7225□L-TE		100	X7S	2.2 μ	±10, ±20	3.5	150	1.6±0.20	R

【温度特性 B7 : X7R】厚度 1.6mm (L)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度 ⁴³ [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
HMK316 B7473□L-T		100	Standard Type	X7R 0.047 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 B7683□L-T				X7R 0.068 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 B7104□L-T				X7R 0.1 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 B7154□L-T				X7R 0.15 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 B7224□L-T				X7R 0.22 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 B7334□L-T				X7R 0.33 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 B7474□L-T				X7R 0.47 μ	±10, ±20	3.5	200	1.6±0.20	R
HMK316 B7105□L-T				X7R 1 μ	±10, ±20	3.5	200	1.6±0.20	R
QMK316 B7333□L-T				X7R 0.033 μ	±10, ±20	2.5	150	1.6±0.20	R
QMK316 B7473□L-T				X7R 0.047 μ	±10, ±20	2.5	150	1.6±0.20	R
QMK316 B7683□L-T				X7R 0.068 μ	±10, ±20	2.5	150	1.6±0.20	R
QMK316 B7104□L-T				X7R 0.1 μ	±10, ±20	2.5	150	1.6±0.20	R
SMK316 B7153□L-T				X7R 0.015 μ	±10, ±20	2.5	120	1.6±0.20	R
SMK316 B7223□L-T				X7R 0.022 μ	±10, ±20	2.5	120	1.6±0.20	R

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【温度特性 B7 : X7R】厚度 1.15mm (F)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
SMK316 B7102□F-T		630	X7R		1000 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 B7152□F-T			X7R		1500 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 B7222□F-T			X7R		2200 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 B7332□F-T			X7R		3300 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 B7472□F-T			X7R		4700 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 B7682□F-T			X7R		6800 p	±10, ±20	2.5	120	1.15±0.10	R
SMK316 B7103□F-T			X7R		0.01 μ	±10, ±20	2.5	120	1.15±0.10	R

【温度特性 SD : Standard】厚度 1.6mm (L)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK316 SD223KL-T		100	Standard Type		0.022 μ	±10	0.1	200	1.6±0.20	R
QMK316 SD103KL-T		250			0.01 μ	±10	0.1	150	1.6±0.20	R

● 325型

【温度特性 BJ : B/X5R】厚度 2.5mm (M)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK325 BJ225□M-P		100	B	X5R ¹	2.2 μ	±10, ±20	3.5	200	2.5±0.20	R
HMK325 BJ475□M-PE		100	B	X5R ¹	4.7 μ	±10, ±20	3.5	150	2.5±0.20	R

【温度特性 BJ : B/X5R】厚度 1.9mm (N)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK325 BJ154□N-T		100	B	X5R ¹	0.15 μ	±10, ±20	3.5	200	1.9±0.20	R
HMK325 BJ224□N-T			B	X5R ¹	0.22 μ	±10, ±20	3.5	200	1.9±0.20	R
HMK325 BJ334□N-T			B	X5R ¹	0.33 μ	±10, ±20	3.5	200	1.9±0.20	R
HMK325 BJ474□N-T			B	X5R ¹	0.47 μ	±10, ±20	3.5	200	1.9±0.20	R
HMK325 BJ684□N-T			B	X5R ¹	0.68 μ	±10, ±20	3.5	200	1.9±0.20	R
HMK325 BJ105□N-T			B	X5R ¹	1 μ	±10, ±20	3.5	200	1.9±0.20	R
HMK325 BJ475□N-TE			B	X5R ¹	4.7 μ	±10, ±20	3.5	150	1.9±0.20	R
QMK325 BJ473□N-T		250	B	X5R ¹	0.047 μ	±10, ±20	2.5	150	1.9±0.20	R
QMK325 BJ104□N-T			B	X5R ¹	0.1 μ	±10, ±20	2.5	150	1.9±0.20	R
QMK325 BJ154□N-T			B	X5R ¹	0.15 μ	±10, ±20	2.5	150	1.9±0.20	R
QMK325 BJ224□N-T		630	B	X5R ¹	0.22 μ	±10, ±20	2.5	150	1.9±0.20	R
SMK325 BJ223□N-T			B	X5R ¹	0.022 μ	±10, ±20	2.5	120	1.9±0.20	R
SMK325 BJ333□N-T			B	X5R ¹	0.033 μ	±10, ±20	2.5	120	1.9±0.20	R
SMK325 BJ473□N-T			B	X5R ¹	0.047 μ	±10, ±20	2.5	120	1.9±0.20	R

【温度特性 BJ : B/X5R】厚度 1.15mm (F)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK325 BJ104□F-T		100	B	X5R ¹	0.1 μ	±10, ±20	3.5	200	1.15±0.10	R

【温度特性 B7 : X7R】厚度 2.5mm (M)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK325 B7225□M-P		100	X7R		2.2 μ	±10, ±20	3.5	200	2.5±0.20	R

【温度特性 B7 : X7R】厚度 1.9mm (N)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK325 B7154□N-T		100	X7R		0.15 μ	±10, ±20	3.5	200	1.9±0.20	R
HMK325 B7224□N-T			X7R		0.22 μ	±10, ±20	3.5	200	1.9±0.20	R
HMK325 B7334□N-T			X7R		0.33 μ	±10, ±20	3.5	200	1.9±0.20	R
HMK325 B7474□N-T			X7R		0.47 μ	±10, ±20	3.5	200	1.9±0.20	R
HMK325 B7684□N-T			X7R		0.68 μ	±10, ±20	3.5	200	1.9±0.20	R
HMK325 B7105□N-T			X7R		1 μ	±10, ±20	3.5	200	1.9±0.20	R
QMK325 B7473□N-T			X7R		0.047 μ	±10, ±20	2.5	150	1.9±0.20	R
QMK325 B7104□N-T		250	X7R		0.1 μ	±10, ±20	2.5	150	1.9±0.20	R
QMK325 B7154□N-T			X7R		0.15 μ	±10, ±20	2.5	150	1.9±0.20	R
QMK325 B7224□N-T			X7R		0.22 μ	±10, ±20	2.5	150	1.9±0.20	R
SMK325 B7223□N-T		630	X7R		0.022 μ	±10, ±20	2.5	120	1.9±0.20	R
SMK325 B7333□N-T			X7R		0.033 μ	±10, ±20	2.5	120	1.9±0.20	R
SMK325 B7473□N-T			X7R		0.047 μ	±10, ±20	2.5	120	1.9±0.20	R

【温度特性 C7 : X7S】厚度 2.5mm (M)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK325 C7475□M-PE		100	X7S		4.7 μ	±10, ±20	3.5	150	2.5±0.20	R

【温度特性 C7 : X7S】厚度 1.9mm (N)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
								额定电压 x %		
HMK325 C7475□N-TE		100	X7S		4.7 μ	±10, ±20	3.5	150	1.9±0.20	R

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【温度特性 B7 : X7R】厚度 1.15 mm (F)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
HMK325 B7104□F-T		100	X7R	0.1 μ	±10, ±20	3.5	200	1.15±0.10	R

● 432型

【温度特性 BJ : B/X5R】厚度 2.5mm (M)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊	
								额定电压 x %			
HMK432 BJ474□M-T		100	B	X5R ⁺¹	0.47 μ	±10, ±20	3.5	200	2.5±0.20	R	
HMK432 BJ105□M-T			B	X5R ⁺¹	1 μ	±10, ±20	3.5	200	2.5±0.20	R	
HMK432 BJ155□M-T			B	X5R ⁺¹	1.5 μ	±10, ±20	3.5	200	2.5±0.20	R	
HMK432 BJ225□M-T			B	X5R ⁺¹	2.2 μ	±10, ±20	3.5	200	2.5±0.20	R	
QMK432 BJ104□M-T			250	B	X5R ⁺¹	0.1 μ	±10, ±20	2.5	150	2.5±0.20	R
QMK432 BJ224□M-T				B	X5R ⁺¹	0.22 μ	±10, ±20	2.5	150	2.5±0.20	R
QMK432 BJ334□M-T		B		X5R ⁺¹	0.33 μ	±10, ±20	2.5	150	2.5±0.20	R	
QMK432 BJ474□M-T		B		X5R ⁺¹	0.47 μ	±10, ±20	2.5	150	2.5±0.20	R	
SMK432 BJ473□M-T		630		B	X5R ⁺¹	0.047 μ	±10, ±20	2.5	120	2.5±0.20	R
SMK432 BJ683□M-T				B	X5R ⁺¹	0.068 μ	±10, ±20	2.5	120	2.5±0.20	R
SMK432 BJ104□M-T			B	X5R ⁺¹	0.1 μ	±10, ±20	2.5	120	2.5±0.20	R	

【温度特性 B7 : X7R】厚度 2.5mm (M)

型号1	型号2	额定电压 [V]	温度特性		静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊	
								额定电压 x %			
HMK432 B7474□M-T		100		X7R	0.47 μ	±10, ±20	3.5	200	2.5±0.20	R	
HMK432 B7105□M-T				X7R	1 μ	±10, ±20	3.5	200	2.5±0.20	R	
HMK432 B7155□M-T				X7R	1.5 μ	±10, ±20	3.5	200	2.5±0.20	R	
HMK432 B7225□M-T				X7R	2.2 μ	±10, ±20	3.5	200	2.5±0.20	R	
QMK432 B7104□M-T			250		X7R	0.1 μ	±10, ±20	2.5	150	2.5±0.20	R
QMK432 B7224□M-T					X7R	0.22 μ	±10, ±20	2.5	150	2.5±0.20	R
QMK432 B7334□M-T				X7R	0.33 μ	±10, ±20	2.5	150	2.5±0.20	R	
QMK432 B7474□M-T				X7R	0.47 μ	±10, ±20	2.5	150	2.5±0.20	R	
SMK432 B7473□M-T		630			X7R	0.047 μ	±10, ±20	2.5	120	2.5±0.20	R
SMK432 B7683□M-T					X7R	0.068 μ	±10, ±20	2.5	120	2.5±0.20	R
SMK432 B7104□M-T				X7R	0.1 μ	±10, ±20	2.5	120	2.5±0.20	R	

▶ 由于篇幅有限, 本产品目录中只记载了有代表性的产品规格, 若考虑使用弊公司产品时, 请确认交货规格说明书中的详细规格。另外, 有关各产品的详细信息(特性图、可靠性信息、使用时的注意事项等), 请参阅弊网站(<http://www.ty-top.com/>)。

LW 逆转型多层陶瓷电容器 (LWDC™)

● 105型

【温度特性 BJ: X5R】厚度 0.3mm (P)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
TWK105 BJ104MP-F		25	X5R	0.1 μ	±20	5	150	0.3±0.05	R
EWK105 BJ224MP-F		16	X5R	0.22 μ	±20	10	150	0.3±0.05	R
LWK105 BJ474MP-F		10	X5R	0.47 μ	±20	10	150	0.3±0.05	R
JWK105 BJ104MP-F		6.3	X5R ^{*1}	0.1 μ	±20	5	150	0.3±0.05	R
JWK105 BJ474MP-F			X5R ^{*1}	0.47 μ	±20	10	150	0.3±0.05	R
JWK105 BJ105MP-F			X5R	1 μ	±20	10	150	0.3±0.05	R
JWK105 BJ225MP-F			X5R	2.2 μ	±20	10	150	0.3±0.05	R

【温度特性 C6: X6S, C7: X7S】厚度 0.3mm (P)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
EWK105 C6104MP-F		16	X6S	0.1 μ	±20	5	150	0.3±0.05	R
LWK105 C7104MP-F		10	X7S	0.1 μ	±20	5	150	0.3±0.05	R
LWK105 C6224MP-F			X6S	0.22 μ	±20	10	150	0.3±0.05	R
JWK105 C7104MP-F		6.3	X7S	0.1 μ	±20	5	150	0.3±0.05	R
JWK105 C7224MP-F			X7S	0.22 μ	±20	10	150	0.3±0.05	R
JWK105 C6474MP-F			X6S	0.47 μ	±20	10	150	0.3±0.05	R
AWK105 C6224MP-F			X6S	0.22 μ	±20	10	150	0.3±0.05	R
AWK105 C6474MP-F			X6S	0.47 μ	±20	10	150	0.3±0.05	R
AWK105 C6105MP-F		4	X6S	1 μ	±20	10	150	0.3±0.05	R
AWK105 C6225MP-F			X6S	2.2 μ	±20	10	150	0.3±0.05	R

● 107型

【温度特性 BJ: X5R】厚度 0.5mm (V)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊	
							额定电压 x %			
TWK107 BJ104MV-T		25	X5R ^{*1}	0.1 μ	±20	5	150	0.5±0.05	R	
EWK107 BJ224MV-T		16	X5R ^{*1}	0.22 μ	±20	5	150	0.5±0.05	R	
EWK107 BJ474MV-T			X5R ^{*1}	0.47 μ	±20	5	150	0.5±0.05	R	
LWK107 BJ105MV-T		10	X5R	1 μ	±20	10	150	0.5±0.05	R	
LWK107 BJ225MV-T			X5R	2.2 μ	±20	10	150	0.5±0.05	R	
JWK107 BJ105MV-T		6.3	X5R ^{*1}	1 μ	±20	10	150	0.5±0.05	R	
JWK107 BJ225MV-T			X5R	2.2 μ	±20	10	150	0.5±0.05	R	
JWK107 BJ475MV-T			X5R	4.7 μ	±20	10	150	0.5±0.05	R	
AWK107 BJ106MV-T			4	X5R	10 μ	±20	10	150	0.5±0.05	R

【温度特性 B7: X7R, C6: X6S, C7: X7S】厚度 0.5mm (V)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
TWK107 B7104MV-T		25	X7R	0.1 μ	±20	5	150	0.5±0.05	R
EWK107 B7224MV-T		16	X7R	0.22 μ	±20	5	150	0.5±0.05	R
EWK107 B7474MV-T			X7R	0.47 μ	±20	5	150	0.5±0.05	R
JWK107 C7105MV-T		6.3	X7S	1 μ	±20	10	150	0.5±0.05	R
AWK107 C7225MV-T			X7S	2.2 μ	±20	10	150	0.5±0.05	R
AWK107 C6475MV-T		4	X6S	4.7 μ	±20	10	150	0.5±0.05	R
PWK107 C6106MV-T			2.5	X6S	10 μ	±20	10	150	0.5±0.05

● 212型

【温度特性 BJ: X5R】厚度 0.85mm (D)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
TWK212 BJ475□D-T		25	X5R	4.7 μ	±10, ±20	10	150	0.85±0.10	R
EWK212 BJ106MD-T		16	X5R	10 μ	±20	10	150	0.85±0.10	R
LWK212 BJ475□D-T		10	X5R	4.7 μ	±10, ±20	10	150	0.85±0.10	R
LWK212 BJ106MD-T			X5R	10 μ	±20	10	150	0.85±0.10	R
JWK212 BJ226MD-T		6.3	X5R	22 μ	±20	10	150	0.85±0.10	R

【温度特性 B7: X7R, C6: X6S】厚度 0.85mm (D)

型号1	型号2	额定电压 [V]	温度特性	静电容量 [F]	静电容量允许偏差 [%]	tan δ [%]	高温负载	厚度*3 [mm]	焊接方式 R: 回流焊 W: 波峰焊
							额定电压 x %		
TWK212 B7225□D-T		25	X7R	2.2 μ	±10, ±20	5	150	0.85±0.10	R
EWK212 C6475□D-T		16	X6S	4.7 μ	±10, ±20	10	150	0.85±0.10	R
LWK212 C6106MD-T		10	X6S	10 μ	±20	10	150	0.85±0.10	R
AWK212 C6226MD-T		4	X6S	22 μ	±20	10	150	0.85±0.10	R

Multilayer Ceramic Capacitors

PACKAGING

① Minimum Quantity

● Taped package

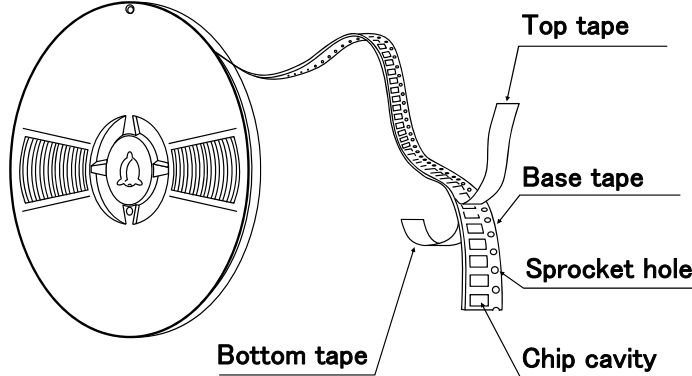
Type(EIA)	Thickness		Standard quantity [pcs]	
	mm	code	Paper tape	Embossed tape
□MK021(008004)	0.125	K	—	50000
□MK042(01005)	0.2	C, D	—	40000
□VS042(01005)	0.2	C		
□MK063(0201)	0.3	P, T	15000	—
□WK105(0204) ※	0.3	P	10000	—
□MK105(0402)	0.13	H	—	20000
	0.18	E	—	15000
	0.2	C	20000	—
	0.3	P	15000	—
	0.5	V	10000	—
□VK105(0402)	0.5	W	10000	—
□MK107(0603)	0.45	K	4000	—
□WK107(0306) ※	0.5	V	—	4000
□MR107(0603)	0.8	A	4000	—
□VS107(0603)	0.7	C	4000	—
□MJ107(0603)	0.8	A	3000	3000
□MK212(0805)	0.45	K	4000	—
□WK212(0508) ※	0.85	D		
□MR212(0805)	1.25	G	—	3000
□VS212(0805)	0.85	D	4000	—
□MJ212(0805)	0.85	D	4000	—
	1.25	G	—	2000
□MK316(1206)	0.85	D	4000	—
□MR316(1206)	1.15	F	—	3000
	1.6	L	—	2000
□MJ316(1206)	1.15	F	—	3000
	1.6	L	—	2000
□MK325(1210) □MR325(1210)	0.85	D	—	2000
	1.15	F		
	1.9	N		
	2.0max.	Y		
□MJ325(1210)	1.9	N	—	2000
	2.5	M	—	500(T), 1000(P)
□MK432(1812)	2.5	M	—	500

Note : ※ LW Reverse type.

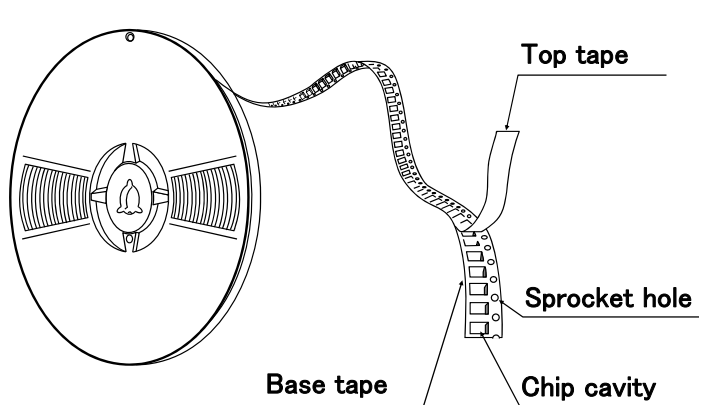
② Taping material

※No bottom tape for pressed carrier tape

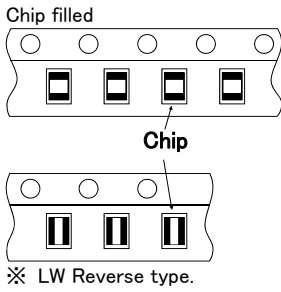
● Card board carrier tape



● Embossed tape



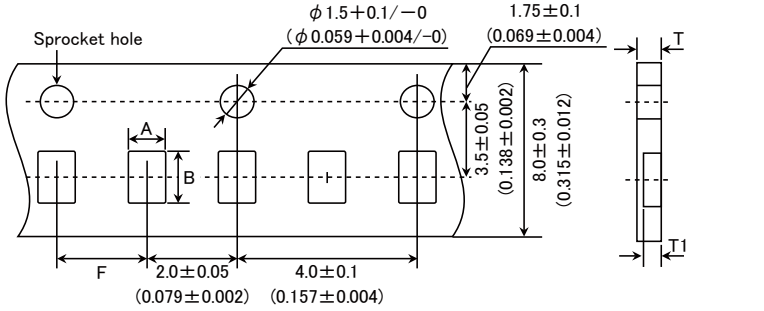
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③ Representative taping dimensions

● Paper Tape (8mm wide)

● Pressed carrier tape (2mm pitch)

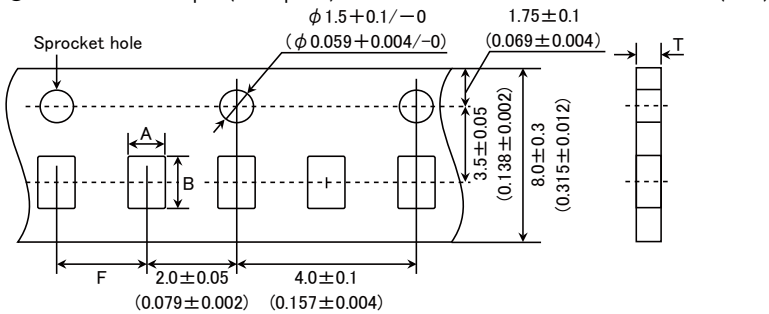


Type(EIA)	Chip Cavity		Insertion Pitch F	Tape Thickness	
	A	B		T	T1
□MK063(0201)	0.37	0.67	2.0±0.05	0.45max.	0.42max.
□WK105(0204) ※	0.65	1.15		0.4max.	0.3max.
□MK105(0402) (*1 C)				0.45max.	0.42max.
□MK105(0402) (*1 P)					

Note *1 Thickness, C: 0.2mm ,P: 0.3mm. ※ LW Reverse type.

Unit: mm

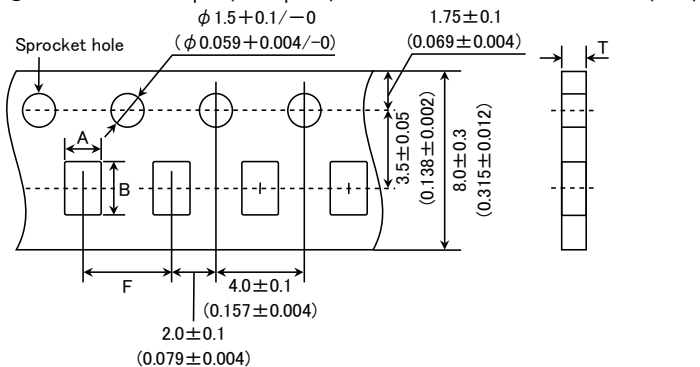
● Punched carrier tape (2mm pitch)



Type(EIA)	Chip Cavity		Insertion Pitch F	Tape Thickness
	A	B		T
□MK105 (0402)	0.65	1.15	2.0±0.05	0.8max.
□VK105 (0402)				

Unit: mm

● Punched carrier tape (4mm pitch)



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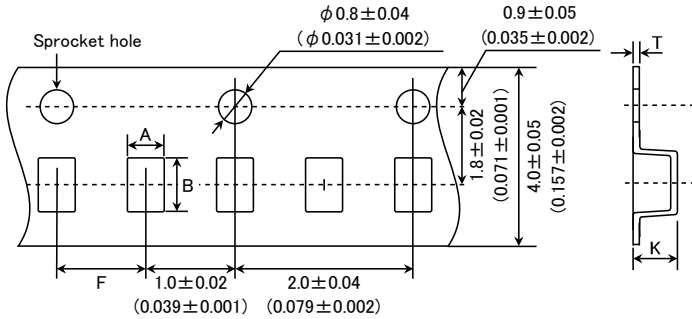
Type(EIA)	Chip Cavity		Insertion Pitch	Tape Thickness
	A	B	F	T
□MK107(0603) □WK107(0306) ※ □MR107(0603)	1.0	1.8	4.0±0.1	1.1max.
□MK212(0805) □WK212(0508) ※ □MK316(1206)	1.65	2.4		1.1max.
	2.0	3.6		

Note: Taping size might be different depending on the size of the product. ※ LW Reverse type.

Unit: mm

● Embossed tape (4mm wide)

Unit: mm (inch)

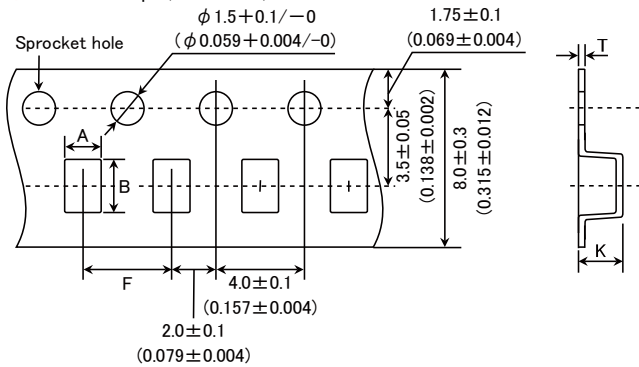


Type(EIA)	Chip Cavity		Insertion Pitch	Tape Thickness	
	A	B	F	K	T
□MK021(008004) □MK042(01005)	0.135	0.27	1.0±0.02	0.5max.	0.25max.
□VS042(01005)	0.23	0.43			

Unit: mm

● Embossed tape (8mm wide)

Unit: mm (inch)

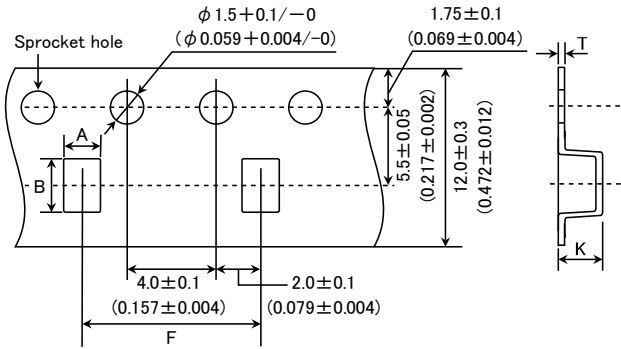


Type(EIA)	Chip Cavity		Insertion Pitch	Tape Thickness	
	A	B	F	K	T
□MK105(0402) □WK107(0306) ※ □MK212(0805) □MR212(0805)	0.6	1.1	2.0±0.1	0.6max	0.2±0.1
□MK316(1206) □MR316(1206)	2.0	3.6	4.0±0.1	3.4max.	0.6max.
□MK325(1210) □MR325(1210)	2.8	3.6			

Note: ※ LW Reverse type.

Unit: mm

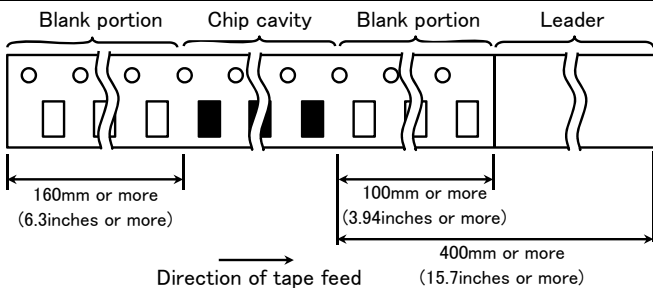
● Embossed tape (12mm wide) Unit: mm (inch)



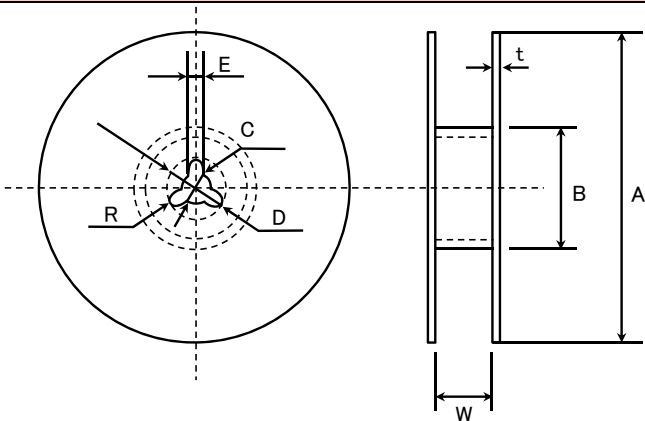
Type(EIA)	Chip Cavity		Insertion Pitch	Tape Thickness	
	A	B	F	K	T
□MK325(1210)	3.1	4.0	8.0±0.1	4.0max.	0.6max.
□MK432(1812)	3.7	4.9	8.0±0.1	4.0max.	0.6max.

Unit: mm

④Trailer and Leader



⑤Reel size



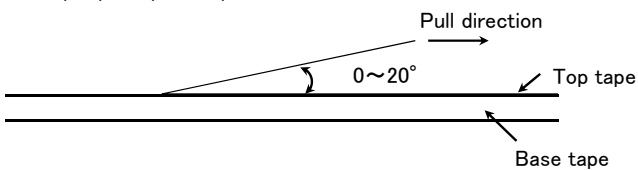
A	B	C	D	E	R
φ178±2.0	φ50min.	φ13.0±0.2	φ21.0±0.8	2.0±0.5	1.0

	T	W
4mm wide tape	1.5max.	5±1.0
8mm wide tape	2.5max.	10±1.5
12mm wide tape	2.5max.	14±1.5

Unit: mm

⑥Top Tape Strength

The top tape requires a peel-off force of 0.1 to 0.7N in the direction of the arrow as illustrated below.



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Multilayer Ceramic Capacitors

RELIABILITY DATA

1. Operating Temperature Range

Specified Value	Temperature Compensating(Class1)	Standard	-55 to +125°C		
		High Frequency Type			
Specified Value	High Permittivity (Class2)		Specification	Temperature Range	
		BJ	B	-25 to +85°C	
			X5R	-55 to +85°C	
		B7	X7R	-55 to +125°C	
		C6	X6S	-55 to +105°C	
		C7	X7S	-55 to +125°C	
	LD(※)	X5R	-55 to +85°C		
Note: ※LD Low distortion high value multilayer ceramic capacitor					

2. Storage Conditions

Specified Value	Temperature Compensating(Class1)	Standard	-55 to +125°C		
		High Frequency Type			
Specified Value	High Permittivity (Class2)		Specification	Temperature Range	
		BJ	B	-25 to +85°C	
			X5R	-55 to +85°C	
		B7	X7R	-55 to +125°C	
		C6	X6S	-55 to +105°C	
		C7	X7S	-55 to +125°C	
	LD(※)	X5R	-55 to +85°C		
Note: ※LD Low distortion high value multilayer ceramic capacitor					

3. Rated Voltage

Specified Value	Temperature Compensating(Class1)	Standard	50VDC, 25VDC, 16VDC
		High Frequency Type	50VDC, 25VDC, 16VDC
	High Permittivity (Class2)		50VDC, 35VDC, 25VDC, 16VDC, 10VDC, 6.3VDC, 4VDC, 2.5VDC

4. Withstanding Voltage (Between terminals)

Specified Value	Temperature Compensating(Class1)	Standard	No breakdown or damage	
		High Frequency Type		
Test Methods and Remarks	High Permittivity (Class2)		Class 1	Class 2
	Applied voltage		Rated voltage × 3	Rated voltage × 2.5
	Duration		1 to 5 sec.	
	Charge/discharge current		50mA max.	

5. Insulation Resistance

Specified Value	Temperature Compensating(Class1)	Standard	10000 MΩ min.
		High Frequency Type	
	High Permittivity (Class2) Note 1		C ≤ 0.047 μF : 10000 MΩ min. C > 0.047 μF : 500MΩ·μF
Test Methods and Remarks	Applied voltage	: Rated voltage	
	Duration	: 60 ± 5 sec.	
	Charge/discharge current	: 50mA max.	

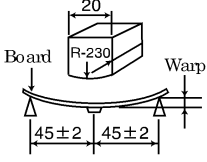
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6. Capacitance (Tolerance)						
Specified Value	Temperature Compensating(Class1)	Standard	C□	0.2pF ≤ C ≤ 5pF : ±0.25pF		
			U□	0.2pF ≤ C ≤ 10pF : ±0.5pF		
	SL	C > 10pF : ±5% or ±10%				
High Permittivity (Class2)	High Frequency Type	CG	0.2pF ≤ C ≤ 2pF	: ±0.1pF		
			C > 2pF	: ±5%		
High Permittivity (Class2)		±10% or ±20%				
Test Methods and Remarks			Class 1		Class 2	
			Standard	High Frequency Type	C ≤ 10 μF	C > 10 μF
	Preconditioning		None		Thermal treatment (at 150°C for 1hr) Note 2	
	Measuring frequency		1MHz ± 10%		1kHz ± 10%	120 ± 10Hz
	Measuring voltage Nte		0.5 to 5Vrms		1 ± 0.2Vrms	0.5 ± 0.1Vrms
Bias application		None				

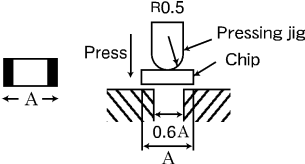
7. Q or Dissipation Factor						
Specified Value	Temperature Compensating(Class1)	Standard	C < 30pF : Q ≥ 400 + 20C			
			C ≥ 30pF : Q ≥ 1000 (C: Nominal capacitance)			
	High Frequency Type	Refer to detailed specification				
High Permittivity (Class2) Note 1		BJ, B7, C6, C7: 2.5% max.				
Test Methods and Remarks			Class 1		Class 2	
			Standard	High Frequency Type	C ≤ 10 μF	C > 10 μF
	Preconditioning		None		Thermal treatment (at 150°C for 1hr) Note 2	
	Measuring frequency		1MHz ± 10%	1GHz	1kHz ± 10%	120 ± 10Hz
	Measuring voltage Note 1		0.5 to 5Vrms		1 ± 0.2Vrms	0.5 ± 0.1Vrms
Bias application		None				
High Frequency Type		Measuring equipment : HP4291A				
		Measuring jig : HP16192A				

8. Temperature Characteristic (Without voltage application)						
Specified Value	Temperature Compensating(Class1)	Standard	Temperature Characteristic [ppm/°C]		Tolerance [ppm/°C]	
			C□ : 0	CG	G : ±30	
	U□ : -750	UJ, UK	J : ±120		K : ±250	
		SL	: +350 to -1000			
High Permittivity (Class2)	High Frequency Type		Temperature Characteristic [ppm/°C]		Tolerance [ppm/°C]	
			C□ : 0	CG	G : ±30	
			Specification	Capacitance change	Reference temperature	Temperature Range
		BJ	B	±10%	20°C	-25 to +85°C
			X5R	±15%	25°C	-55 to +85°C
		B7	X7R	±15%	25°C	-55 to +125°C
		C6	XS	±22%	25°C	-55 to +105°C
		C7	X7S	±22%	25°C	-55 to +125°C
		LD(※)	X5R	±15%	25°C	-55 to +85°C
Note : ※LD Low distortion high value multilayer ceramic capacitor						
Test Methods and Remarks	Class 1					
	Capacitance at 20°C and 85°C shall be measured in thermal equilibrium, and the temperature characteristic shall be calculated from the following equation.					
	$\frac{(C_{85} - C_{20})}{C_{20} \times \Delta T} \times 10^6 (\text{ppm}/^\circ\text{C}) \quad \Delta T = 65$					
	Class 2					
	Capacitance at each step shall be measured in thermal equilibrium, and the temperature characteristic shall be calculated from the following equation.					
		Step	B	X5R, X7R, X6S, X7S		
		1	Minimum operating temperature			
		2	20°C	25°C		
		3	Maximum operating temperature			
		$\frac{(C - C_2)}{C_2} \times 100 (\%)$		C : Capacitance in Step 1 or Step 3 C ₂ : Capacitance in Step 2		

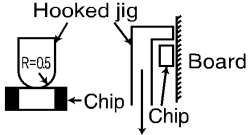
9. Deflection				
<p>This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).</p>				

Specified Value	Temperature Compensating(Class1)	Standard	Appearance : No abnormality Capacitance change : Within $\pm 5\%$ or ± 0.5 pF, whichever is larger.																		
		High Frequency Type	Appearance : No abnormality Capacitance change : Within ± 0.5 pF																		
	High Permittivity (Class2)		Appearance : No abnormality Capacitance change : Within $\pm 12.5\%$																		
Test Methods and Remarks	<table border="1"> <tr> <td></td> <td colspan="2">Multilayer Ceramic Capacitors</td> </tr> <tr> <td></td> <td>021, 042, 063, *105 Type</td> <td>The other types</td> </tr> <tr> <td>Board</td> <td colspan="2">Glass epoxy-resin substrate</td> </tr> <tr> <td>Thickness</td> <td>0.8mm</td> <td>1.6mm</td> </tr> <tr> <td>Warp</td> <td colspan="2">1mm</td> </tr> <tr> <td>Duration</td> <td colspan="2">10 sec.</td> </tr> </table>			Multilayer Ceramic Capacitors			021, 042, 063, *105 Type	The other types	Board	Glass epoxy-resin substrate		Thickness	0.8mm	1.6mm	Warp	1mm		Duration	10 sec.		 <p>(Unit: mm)</p> <p>Capacitance measurement shall be conducted with the board bent</p>
		Multilayer Ceramic Capacitors																			
	021, 042, 063, *105 Type	The other types																			
Board	Glass epoxy-resin substrate																				
Thickness	0.8mm	1.6mm																			
Warp	1mm																				
Duration	10 sec.																				
	*105 Type thickness, C: 0.2mm ,P: 0.3mm.																				

10. Body Strength

Specified Value	Temperature Compensating(Class1)	Standard	—
		High Frequency Type	No mechanical damage.
	High Permittivity (Class2)		—
Test Methods and Remarks	High Frequency Type Applied force : 5N Duration : 10 sec.		
			

11. Adhesive Strength of Terminal Electrodes

Specified Value	Temperature Compensating(Class1)	Standard	No terminal separation or its indication.												
		High Frequency Type													
	High Permittivity (Class2)														
Test Methods and Remarks	<table border="1"> <tr> <td></td> <td colspan="2">Multilayer Ceramic Capacitors</td> </tr> <tr> <td></td> <td>021, 042, 063 Type</td> <td>105 Type or more</td> </tr> <tr> <td>Applied force</td> <td>2N</td> <td>5N</td> </tr> <tr> <td>Duration</td> <td colspan="2">30 ± 5 sec.</td> </tr> </table>			Multilayer Ceramic Capacitors			021, 042, 063 Type	105 Type or more	Applied force	2N	5N	Duration	30 ± 5 sec.		
		Multilayer Ceramic Capacitors													
	021, 042, 063 Type	105 Type or more													
Applied force	2N	5N													
Duration	30 ± 5 sec.														

12. Solderability

Specified Value	Temperature Compensating(Class1)	Standard	At least 95% of terminal electrode is covered by new solder.
		High Frequency Type	
	High Permittivity (Class2)		
Test Methods and Remarks	Eutectic solder		Lead-free solder
	Solder type	H60A or H63A	Sn-3.0Ag-0.5Cu
	Solder temperature	230 ± 5°C	245 ± 3°C
	Duration	4 ± 1 sec.	

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13. Resistance to Soldering

Specified Value	Temperature Compensating(Class1)	Standard	Appearance : No abnormality Capacitance change : Within $\pm 2.5\%$ or $\pm 0.25\text{pF}$, whichever is larger. Q : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals) : No abnormality
		High Frequency Type	Appearance : No abnormality Capacitance change : Within $\pm 2.5\%$ Q : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals) : No abnormality
	High Permittivity (Class2) Note 1		Appearance : No abnormality Capacitance change : Within $\pm 7.5\%$ Dissipation factor : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals): No abnormality

Test Methods and Remarks	Class 1			
		021, 042, 063 Type	105 Type	
	Preconditioning	None		
	Preheating	150°C, 1 to 2 min.	80 to 100°C, 2 to 5 min. 150 to 200°C, 2 to 5 min.	
	Solder temp.	270 \pm 5°C		
	Duration	3 \pm 0.5 sec.		
	Recovery	6 to 24 hrs (Standard condition) Note 5		
	Class 2			
		021, 042, 063 Type	105, 107, 212 Type	316, 325, 432 Type
	Preconditioning	Thermal treatment (at 150°C for 1 hr) Note 2		
	Preheating	150°C, 1 to 2 min.	80 to 100°C, 2 to 5 min. 150 to 200°C, 2 to 5 min.	80 to 100°C, 5 to 10 min. 150 to 200°C, 5 to 10 min.
	Solder temp.	270 \pm 5°C		
	Duration	3 \pm 0.5 sec.		
	Recovery	24 \pm 2 hrs (Standard condition) Note 5		

14. Temperature Cycle (Thermal Shock)

Specified Value	Temperature Compensating(Class1)	Standard	Appearance : No abnormality Capacitance change : Within $\pm 2.5\%$ or $\pm 0.25\text{pF}$, whichever is larger. Q : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals) : No abnormality
		High Frequency Type	Appearance : No abnormality Capacitance change : Within $\pm 0.25\text{pF}$ Q : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals) : No abnormality
	High Permittivity (Class2) Note 1		Appearance : No abnormality Capacitance change : Within $\pm 7.5\%$ Dissipation factor : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals) : No abnormality

Test Methods and Remarks	Class 1		Class 2		
	Preconditioning	None		Thermal treatment (at 150°C for 1 hr) Note 2	
	1 cycle	Step	Temperature (°C)	Time (min.)	
		1	Minimum operating temperature	30 \pm 3	
		2	Normal temperature	2 to 3	
		3	Maximum operating temperature	30 \pm 3	
4	Normal temperature	2 to 3			
Number of cycles	5 times				
Recovery	6 to 24 hrs (Standard condition) Note 5		24 \pm 2 hrs (Standard condition) Note 5		

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15. Humidity (Steady State)

Specified Value	Temperature Compensating(Class1)	Standard	Appearance : No abnormality Capacitance change : Within $\pm 5\%$ or $\pm 0.5\text{pF}$, whichever is larger. Q : $C < 10\text{pF} : Q \geq 200 + 10C$ $10 \leq C < 30\text{pF} : Q \geq 275 + 2.5C$ $C \geq 30\text{pF} : Q \geq 350 (C : \text{Nominal capacitance})$ Insulation resistance : $1000 \text{ M}\Omega \text{ min.}$	
		High Frequency Type	Appearance : No abnormality Capacitance change : Within $\pm 0.5\text{pF}$, Insulation resistance : $1000 \text{ M}\Omega \text{ min.}$	
	High Permittivity (Class2) Note 1		Appearance : No abnormality Capacitance change : Within $\pm 12.5\%$ Dissipation factor : 5.0% max. Insulation resistance : $50 \text{ M}\Omega/\mu\text{F}$ or $1000 \text{ M}\Omega$ whichever is smaller.	
Test Methods and Remarks		Class 1		Class 2
		Standard	High Frequency Type	All items
	Preconditioning	None		Thermal treatment (at 150°C for 1 hr) Note 2
	Temperature	$40 \pm 2^\circ\text{C}$	$60 \pm 2^\circ\text{C}$	$40 \pm 2^\circ\text{C}$
	Humidity	90 to 95%RH		90 to 95%RH
	Duration	$500 + 24 / - 0$ hrs		$500 + 24 / - 0$ hrs
	Recovery	6 to 24 hrs (Standard condition) Note 5		24 ± 2 hrs (Standard condition) Note 5

16. Humidity Loading

Specified Value	Temperature Compensating(Class1)	Standard	Appearance : No abnormality Capacitance change : Within $\pm 7.5\%$ or $\pm 0.75\text{pF}$, whichever is larger. Q : $C < 30\text{pF} : Q \geq 100 + 10C/3$ $C \geq 30\text{pF} : Q \geq 200 (C : \text{Nominal capacitance})$ Insulation resistance : $500 \text{ M}\Omega \text{ min.}$	
		High Frequency Type	Appearance : No abnormality Capacitance change : $C \leq 2\text{pF} : \text{Within } \pm 0.4 \text{ pF}$ $C > 2\text{pF} : \text{Within } \pm 0.75 \text{ pF}$ (C:Nominal capacitance) Insulation resistance : $500 \text{ M}\Omega \text{ min.}$	
	High Permittivity (Class2) Note 1		Appearance : No abnormality Capacitance change : Within $\pm 12.5\%$ Dissipation factor : 5.0% max. Insulation resistance : $25 \text{ M}\Omega/\mu\text{F}$ or $500 \text{ M}\Omega$ whichever is smaller.	
Test Methods and Remarks		Class 1		Class 2
		Standard	High Frequency Type	All items
	Preconditioning	None		Voltage treatment (Rated voltage are applied for 1 hour at 40°C) Note 3
	Temperature	$40 \pm 2^\circ\text{C}$	$60 \pm 2^\circ\text{C}$	$40 \pm 2^\circ\text{C}$
	Humidity	90 to 95%RH		90 to 95%RH
	Duration	$500 + 24 / - 0$ hrs		$500 + 24 / - 0$ hrs
	Applied voltage	Rated voltage		Rated voltage
	Charge/discharge current	50mA max.		50mA max.
Recovery	6 to 24 hrs (Standard condition) Note 5		24 ± 2 hrs (Standard condition) Note 5	

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17. High Temperature Loading

Specified Value	Temperature Compensating(Class1)	Standard	Appearance : No abnormality Capacitance change : Within $\pm 3\%$ or $\pm 0.3\text{pF}$, whichever is larger. Q : $C < 10\text{pF}$: $Q \geq 200 + 10C$ $10 \leq C < 30\text{pF}$: $Q \geq 275 + 2.5C$ $C \geq 30\text{pF}$: $Q \geq 350$ (C: Nominal capacitance) Insulation resistance : 1000 M Ω min.
		High Frequency Type	Appearance : No abnormality Capacitance change : Within $\pm 3\%$ or $\pm 0.3\text{pF}$, whichever is larger. Insulation resistance : 1000 M Ω min.
	High Permittivity (Class2) Note 1		Appearance : No abnormality Capacitance change : Within $\pm 12.5\%$ Dissipation factor : 5.0% max. Insulation resistance : 50 M $\Omega\mu\text{F}$ or 1000 M Ω whichever is smaller.

Test Methods and Remarks		Class 1		Class 2		
		Standard	High Frequency Type	BJ, LD(※)	C6	B7, C7
	Preconditioning	None		Voltage treatment (Twice the rated voltage shall be applied for 1 hour at 85°C, 105°C or 125°C) Note 3, 4		
	Temperature	Maximum operating temperature		Maximum operating temperature		
	Duration	1000+48/-0 hrs		1000+48/-0 hrs		
	Applied voltage	Rated voltage $\times 2$ Note 4		Rated voltage $\times 2$ Note 4		
	Charge/discharge current	50mA max.		50mA max.		
	Recovery	6 to 24hr (Standard condition) Note 5		24 ± 2 hrs (Standard condition) Note 5		
Note: ※LD Low distortion high value multilayer ceramic capacitor						

Note 1 The figures indicate typical specifications. Please refer to individual specifications in detail.

Note 2 Thermal treatment : Initial value shall be measured after test sample is heat-treated at 150+0/-10°C for an hour and kept at room temperature for 24 ± 2 hours.

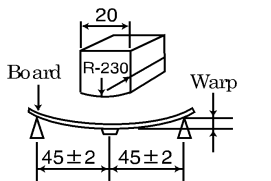
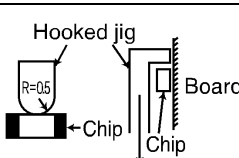
Note 3 Voltage treatment : Initial value shall be measured after test sample is voltage-treated for an hour at both the temperature and voltage specified in the test conditions, and kept at room temperature for 24 ± 2 hours.

Note 4 150% of rated voltage is applicable to some items. Please refer to their specifications for further information.

Note 5 Standard condition: Temperature: 5 to 35°C, Relative humidity: 45 to 85 % RH, Air pressure: 86 to 106kPa When there are questions concerning measurement results, in order to provide correlation data, the test shall be conducted under the following condition.
Temperature: 20 ± 2 °C, Relative humidity: 60 to 70 % RH, Air pressure: 86 to 106kPa Unless otherwise specified, all the tests are conducted under the "standard condition".

Super Low Distortion Multilayer Ceramic Capacitors

RELIABILITY DATA

1. Operating Temperature Range	
Specified Value	-55 to +125°C
2. Storage Temperature Range	
Specified Value	-55 to +125°C
3. Rated Voltage	
Specified Value	6.3VDC, 10VDC, 16VDC, 25VDC, 35VDC, 50VDC
4. Dielectric Withstanding Voltage (Between terminals)	
Specified Value	No breakdown or damage
Test Methods and Remarks	Applied voltage : Rated voltage × 3 Duration : 1 to 5 sec. Charge/discharge current : 50mA max.
5. Insulation Resistance	
Specified Value	10000 MΩ or 500MΩμF, whichever is smaller
Test Methods and Remarks	Applied voltage : Rated voltage Duration : 60±5 sec. Charge/discharge current : 50mA max.
6. Capacitance (Tolerance)	
Specified Value	±10%
Test Methods and Remarks	Measuring frequency : 1kHz±10% Measuring voltage : 1±0.2Vrms Bias application : None
7. Dissipation Factor	
Specified Value	0.1%max
Test Methods and Remarks	Measuring frequency : 1kHz±10% Measuring voltage : 1±0.2Vrms Bias application : None
8. Bending Strength	
Specified Value	Appearance : No abnormality Capacitance change : ±5%
Test Methods and Remarks	Warp : 1mm Speed : 0.5mm/second Duration : 10 seconds Test board : glass epoxy resin substrate Thickness : 1.6mm  (Unit: mm) Capacitance measurement shall be conducted with the board bent.
9. Adhesive Force of Terminal Electrodes	
Specified Value	Terminal electrodes shall be no exfoliation or a sign of exfoliation.
Test Methods and Remarks	Applied force : 5N Duration : 30 ±5 seconds 

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10. Solderability			
Specified Value	At least 95% of terminal electrode is covered by new solder.		
Test Methods and Remarks		Eutectic solder	Lead-free solder
	Solder type	H60A or H63A	Sn-3.0Ag-0.5Cu
	Solder temperature	230±5°C	245±3°C
	Duration	4±1 sec.	
11. Resistance to Soldering Heat			
Specified Value	Appearance	: No abnormality	
	Capacitance change	: ±2.5% max.	
	Dissipation factor	: Initial value	
	Insulation resistance	: Initial value	
	Withstanding voltage	(between terminals) : No abnormality	
Test Methods and Remarks	Solder temp.	: 270 ±5°C	
	Duration	: 3 ±0.5 sec.	
	Preheating conditions	: 80 to 100°C, 2 to 5 min. or 5 to 10 min. 150 to 200°C, 2 to 5 min. or 5 to 10 min.	
	Measurement shall be conducted	: 24±2hrs under the standard condition Note1	
12. Temperature Cycle (Thermal Shock)			
Specified Value	Appearance	: No abnormality	
	Capacitance change	: ±2.5% max	
	Dissipation factor	: Initial value	
	Insulation resistance	: Initial value	
	Withstanding voltage	(between terminals): No abnormality	
Test Methods and Remarks	Conditions for 1 cycle		
	Step	temperature (°C)	Time (min.)
	1	Minimum operating temperature	30±3 min.
	2	Normal temperature	2 to 3 min.
	3	Maximum operating temperature	30±3 min.
	4	Normal temperature	2 to 3 min.
Number of cycles: 5 times			
Measurement shall be conducted : 24±2hrs under the standard condition Note1			
13. Humidity (Steady state)			
Specified Value	Appearance	: No abnormality	
	Capacitance change	: ±5% max	
	Dissipation factor	: 0.5% max	
	Insulation resistance	: 50M ΩμF or 1000M Ω whichever is smaller	
Test Methods and Remarks	Temperature	: 40±2°C	
	Humidity	: 90 to 95% RH	
	Duration	: 500 +24/-0 hrs	
	Measurement shall be conducted	: 24 ±2hrs under the standard condition Note1	
14. Humidity Loading			
Specified Value	Appearance	: No abnormality	
	Capacitance change	: ±7.5% max	
	Dissipation factor	: 0.5% max	
	Insulation resistance	: 25M ΩμF or 500M Ω whichever is smaller	
Test Methods and Remarks	According to JIS C 5101-1.		
	Temperature	: 40±2°C	
	Humidity	: 90 to 95% RH	
	Duration	: 500 +24/-0 hrs	
	Applied voltage	: Rated voltage	
	Charge/discharge current	: 50mA max	
	Measurement shall be conducted	: 24 ±2hrs under the standard condition Note1	

15. High Temperature Loading

Specified Value	Appearance	: No abnormality
	Capacitance change	: $\pm 3\%$ max
	Dissipation factor	: 0.35% max
	Insulation resistance	: 50M Ω μ F or 1000M Ω whichever is smaller
Test Methods and Remarks	According to JIS C 5101-1.	
	Temperature	: Maximum operating temperature
	Duration	: 1000 +48/-0 hrs
	Applied voltage	: Rated voltage x 2
	Charge/discharge current	: 50mA max
Measurement shall be conducted	: 24 \pm 2hrs under the standard condition Note1	

Note1 Standard condition: Temperature: 5 to 35°C, Relative humidity: 45 to 85 % RH, Air pressure: 86 to 106kPa

When there are questions concerning measurement results, in order to provide correlation data, the test shall be conducted under the following condition.

Temperature: 20 \pm 2°C, Relative humidity: 60 to 70 % RH, Air pressure: 86 to 106kPa

Unless otherwise specified, all the tests are conducted under the "standard condition".

Medium-High Voltage Multilayer Ceramic Capacitor

RELIABILITY DATA

1. Operating Temperature Range		
Specified Value	Temperature Compensating(Class1)	CG : -55 to +125°C
	High Permittivity (Class2)	X7R, X7S : -55 to +125°C X5R : -55 to +85°C B : -25 to +85°C SD : -55 to +125°C

2. Storage Temperature Range		
Specified Value	Temperature Compensating(Class1)	CG : -55 to +125°C
	High Permittivity (Class2)	X7R, X7S : -55 to +125°C X5R : -55 to +85°C B : -25 to +85°C SD : -55 to +125°C

3. Rated Voltage		
Specified Value	Temperature Compensating(Class1)	100VDC(HMK)
	High Permittivity (Class2)	100VDC(HMK), 250VDC(QMK), 630VDC(SMK)

4. Withstanding Voltage(Between terminals)		
Specified Value	No breakdown or damage	
Test Methods and Remarks	Applied voltage : Rated voltage × 2.5 (HMK), Rated voltage × 2 (QMK), Rated voltage × 1.2 (SMK) Duration : 1 to 5sec. Charge/discharge current : 50mA max.	

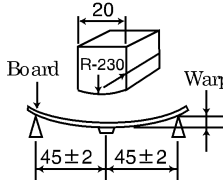
5. Insulation Resistance		
Specified Value	Temperature Compensating(Class1)	10000 MΩ min.
	High Permittivity (Class2)	100MΩ·μF or 10GΩ whichever is smaller.
Test Methods and Remarks	Applied voltage : Rated voltage (HMK, QMK), 500V (SMK) Duration : 60±5sec. Charge/discharge current : 50mA max.	

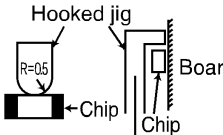
6. Capacitance (Tolerance)		
Specified Value	Temperature Compensating(Class1)	0.2pF ≤ C ≤ 5pF : ±0.25pF 0.2pF ≤ C ≤ 10pF : ±0.5pF C > 10pF : ±5% or ±10%
	High Permittivity (Class2)	±10%, ±20%
Test Methods and Remarks	Temperature Compensating(Class1)	Measuring frequency : 1MHz ± 10% Measuring voltage : 0.5~5Vrms Bias application : None
	High Permittivity (Class2)	Measuring frequency : 1kHz ± 10% Measuring voltage : 1 ± 0.2Vrms Bias application : None

7. Q or Dissipation Factor		
Specified Value	Temperature Compensating(Class1)	C < 30pF : Q ≥ 400 + 20C C ≥ 30pF : Q ≥ 1000 (C: Nominal capacitance)
	High Permittivity (Class2)	3.5%max (HMK), 2.5%max (QMK, SMK)
Test Methods and Remarks	Temperature Compensating(Class1)	Measuring frequency : 1MHz ± 10% Measuring voltage : 0.5~5Vrms Bias application : None
	High Permittivity (Class2)	Measuring frequency : 1kHz ± 10% Measuring voltage : 1 ± 0.2Vrms Bias application : None

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8. Temperature Characteristic of Capacitance													
Specified Value	Temperature Compensating(Class1)	CG : $0 \pm 30 \text{ppm}/^\circ\text{C} (-55 \text{ to } +125^\circ\text{C})$											
	High Permittivity (Class2)	B : $\pm 10\% (-25 \text{ to } +85^\circ\text{C})$ X5R : $\pm 15\% (-55 \text{ to } +85^\circ\text{C})$ X7R : $\pm 15\% (-55 \text{ to } +125^\circ\text{C})$ X7S : $\pm 22\% (-55 \text{ to } +125^\circ\text{C})$ SD : - ($-55 \text{ to } +125^\circ\text{C}$)											
Test Methods and Remarks	Capacitance value at each step shall be measured in thermal equilibrium, and the temperature characteristic shall be calculated from the following equation.												
	<table border="1"> <thead> <tr> <th>Step</th> <th>CG、</th> <th>B、X5R、X7R、X7S、SD</th> </tr> </thead> <tbody> <tr> <td>1</td> <td colspan="2">Minimum operating temperature</td> </tr> <tr> <td>2</td> <td>20°C</td> <td>25°C</td> </tr> <tr> <td>3</td> <td colspan="2">Maximum operating temperature</td> </tr> </tbody> </table>		Step	CG、	B、X5R、X7R、X7S、SD	1	Minimum operating temperature		2	20°C	25°C	3	Maximum operating temperature
Step	CG、	B、X5R、X7R、X7S、SD											
1	Minimum operating temperature												
2	20°C	25°C											
3	Maximum operating temperature												
$\frac{(C - C_2)}{C_2} \times 100(\%)$ <p>C : Capacitance value in Step 1 or Step 3 C2 : Capacitance value in Step 2</p>													

9. Deflection		
Specified Value	Temperature Compensating(Class1)	Appearance : No abnormality Capacitance change : Within $\pm 5\%$ or $\pm 0.5 \text{ pF}$, whichever is larger.
	High Permittivity (Class2)	Appearance : No abnormality Capacitance change : Within $\pm 10\%$
Test Methods and Remarks	Warp : 1mm Duration : 10sec. Test board : Glass epoxy-resin substrate Thickness : 1.6mm	 <p>(Unit: mm)</p>
	Capacitance measurement shall be conducted with the board bent.	

10. Adhesive Strength of Terminal Electrodes		
Specified Value	Temperature Compensating(Class1)	No terminal separation or its indication.
	High Permittivity (Class2)	
Test Methods and Remarks	Applied force : 5N Duration : $30 \pm 5 \text{sec.}$	

11. Solderability			
Specified Value	Temperature Compensating(Class1)	At least 95% of terminal electrode is covered by new solder	
	High Permittivity (Class2)		
Test Methods and Remarks		Eutectic solder	Lead-free solder
	Solder type	H60A or H63A	Sn-3.0Ag-0.5Cu
	Solder temperature	$230 \pm 5^\circ\text{C}$	$245 \pm 3^\circ\text{C}$
	Duration	$4 \pm 1 \text{ sec.}$	

12. Resistance to Soldering		
Specified Value	Temperature Compensating(Class1)	Appearance : No abnormality Capacitance change : Within $\pm 2.5\%$ or $\pm 0.25 \text{pF}$, whichever is larger.(HMK) Q : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals) : No abnormality
	High Permittivity (Class2)	Appearance : No abnormality Capacitance change : Within $\pm 15\%$ (HMK), $\pm 10\%$ (QMK, SMK) Dissipation facto : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals) : No abnormality

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Test Methods and Remarks	Temperature Compensating(Class1)	
	Preconditioning	None
	Solder temperature	270±5°C
	Duration	3±0.5sec.
	Preheating conditions	80 to 100°C, 2 to 5 min. 150 to 200°C, 2 to 5min.
	Recovery	24±2hrs under the standard condition Note3
	High Permittivity (Class2)	
	Preconditioning	Thermal treatment(at 150°C for 1hr) Note1
	Solder temperature	270±5°C
	Duration	3±0.5sec.
	Preheating conditions	80 to 100°C, 2 to 5 min. 150 to 200°C, 2 to 5min.
	Recovery	24±2hrs under the standard condition Note3

13. Temperature Cycle (Thermal Shock)

Specified Value	Temperature Compensating(Class1)	Appearance : No abnormality Capacitance change : Within ±2.5% or ±0.25pF, whichever is larger.(HMK) Q : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals) : No abnormality
	High Permittivity (Class2)	Appearance : No abnormality Capacitance change : Within ±15%(HMK), ±10%(QMK, SMK) Dissipation facto : Initial value Insulation resistance : Initial value Withstanding voltage (between terminals) : No abnormality

Test Methods and Remarks	Class 1		Class 2		
	Preconditioning	None	Thermal treatment (at 150°C for 1 hr) Note 1		
	1 cycle	Step	Temperature(°C)	Time (min.)	
		1	Minimum operating temperature	30±3	
		2	Normal temperature	2 to 3	
		3	Maximum operating temperature	30±3	
4	Normal temperature	2 to 3			
Number of cycles	5 times				
Recovery	6 to 24 hrs (Standard condition) Note 3	24±2 hrs (Standard condition) Note 3			

14. Humidity (Steady state)

Specified Value	Temperature Compensating(Class1)	Appearance : No abnormality Capacitance change : Within ±5% or ±0.5pF, whichever is larger.(HMK) Q : C < 10pF : Q ≥ 200 + 10C 10 ≤ C < 30pF : Q ≥ 275 + 2.5C C ≥ 30pF : Q ≥ 350 (C : Nominal capacitance) Insulation resistance : 1000 M Ω min.
	High Permittivity (Class2)	Appearance : No abnormality Capacitance change : Within ±15% Dissipation factor : 7%max (HMK), 5%max (QMK, SMK). Insulation resistance : 25M Ω μF or 1000M Ω whichever is smaller.

Test Methods and Remarks	Class 1		Class 2	
	Preconditioning	None	Thermal treatment (at 150°C for 1 hr) Note 1	
	Temperature	40±2°C	40±2°C	
	Humidity	90 to 95%RH	90 to 95%RH	
	Duration	500+24/-0 hrs	500+24/-0 hrs	
	Recovery	6 to 24 hrs (Standard condition) Note 3	24±2 hrs (Standard condition) Note 3	

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15. Humidity Loading			
Specified Value	Temperature Compensating(Class1)	Appearance	: No abnormality
		Capacitance change	: Within $\pm 7.5\%$ or $\pm 0.75\text{pF}$, whichever is larger (HMK).
		Q	: $C < 30\text{pF} : Q \geq 100 + 10C/3$ $C \geq 30\text{pF} : Q \geq 200$ (C: Nominal capacitance)
		Insulation resistance	: 500 M Ω min.
	High Permittivity (Class2)	Appearance	: No abnormality
		Capacitance change	: Within $\pm 15\%$
		Dissipation factor	: 7%max (HMK), 5%max (QMK, SMK).
		Insulation resistance	: 10M Ω μ F or 500M Ω whichever is smaller.
Test Methods and Remarks	According to JIS 5101-1.		
		Class 1	Class 2
	Preconditioning	None	Voltage treatment (Rated voltage are applied for 1 hour at 40°C) Note 2
	Temperature	40 \pm 2°C	40 \pm 2°C
	Humidity	90 to 95%RH	90 to 95%RH
	Duration	500+24/-0 hrs	500+24/-0 hrs
	Applied voltage	Rated voltage	Rated voltage
	Charge/discharge current	50mA max.	50mA max.
	Recovery	6 to 24 hrs (Standard condition) Note 3	24 \pm 2 hrs (Standard condition) Note 3

16. High Temperature Loading			
Specified Value	Temperature Compensating(Class1)	Appearance	: No abnormality
		Capacitance change	: Within $\pm 7.5\%$ or $\pm 0.75\text{pF}$, whichever is larger.(HMK)
		Q	: $C < 30\text{pF} : Q \geq 100 + 10C/3$ $C \geq 30\text{pF} : Q \geq 200$ (C: Nominal capacitance)
		Insulation resistance	: 500 M Ω min.
	High Permittivity (Class2)	Appearance	: No abnormality
		Capacitance change	: Within $\pm 15\%$
		Dissipation factor	: 7%max (HMK), 5%max (QMK, SMK).
		Insulation resistance	: 50M Ω μ F or 1000M Ω whichever is smaller.
Test Methods and Remarks	According to JIS 5101-1.		
		Class 1	Class 2
	Preconditioning	None	Voltage treatment Note 2
	Temperature	Maximum operating temperature	Maximum operating temperature
	Duration	1000+48/-0 hrs	1000+48/-0 hrs
	Applied voltage	Rated voltage \times 2(HMK)	Rated voltage \times 2(HMK), Rated voltage \times 1.5 (QMK), Rated voltage \times 1.2 (SMK)
	Charge/discharge current	50mA max.	50mA max.
	Recovery	6 to 24hr (Standard condition) Note 3	24 \pm 2 hrs (Standard condition) Note 3

Note1 Thermal treatment : Initial value shall be measured after test sample is heat-treated at 150+0/-10°C for an hour and kept at room temperature for 24 \pm 2hours.

Note2 Voltage treatment : Initial value shall be measured after test sample is voltage-treated for an hour at both the temperature and voltage specified in the test conditions, and kept at room temperature for 24 \pm 2hours.

Note3 Standard condition : Temperature: 5 to 35°C, Relative humidity: 45 to 85 % RH, Air pressure: 86 to 106kPa

When there are questions concerning measurement results, in order to provide correlation data, the test shall be conducted under the following condition.

Temperature: 20 \pm 2°C, Relative humidity: 60 to 70 % RH, Air pressure: 86 to 106kPa

Unless otherwise specified, all the tests are conducted under the "standard condition".

Precautions on the use of Multilayer Ceramic Capacitors

PRECAUTIONS

1. Circuit Design

◆Verification of operating environment, electrical rating and performance

1. A malfunction of equipment in fields such as medical, aerospace, nuclear control, etc. may cause serious harm to human life or have severe social ramifications.
Therefore, any capacitors to be used in such equipment may require higher safety and reliability, and shall be clearly differentiated from them used in general purpose applications.

◆Operating Voltage (Verification of Rated voltage)

1. The operating voltage for capacitors must always be their rated voltage or less.
If an AC voltage is loaded on a DC voltage, the sum of the two peak voltages shall be the rated voltage or less.
For a circuit where an AC or a pulse voltage may be used, the sum of their peak voltages shall also be the rated voltage or less.

2. Even if an applied voltage is the rated voltage or less reliability of capacitors may be deteriorated in case that either a high frequency AC voltage or a pulse voltage having rapid rise time is used in a circuit.

2. PCB Design

◆Pattern configurations (Design of Land-patterns)

1. When capacitors are mounted on PCBs, the amount of solder used (size of fillet) can directly affect the capacitor performance.
Therefore, the following items must be carefully considered in the design of land patterns:

(1) Excessive solder applied can cause mechanical stresses which lead to chip breaking or cracking. Therefore, please consider appropriate land-patterns for proper amount of solder.

(2) When more than one component are jointly soldered onto the same land, each component's soldering point shall be separated by solder-resist.

◆Pattern configurations (Capacitor layout on PCBs)

After capacitors are mounted on boards, they can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering of the boards, etc.). For this reason, land pattern configurations and positions of capacitors shall be carefully considered to minimize stresses.

◆Pattern configurations (Design of Land-patterns)

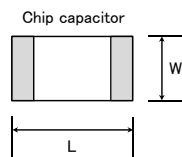
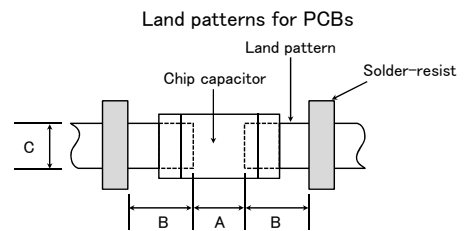
The following diagrams and tables show some examples of recommended land patterns to prevent excessive solder amounts.

(1) Recommended land dimensions for typical chip capacitors

● Multilayer Ceramic Capacitors : Recommended land dimensions (unit: mm)

Wave-soldering

Type		107	212	316	325
Size	L	1.6	2.0	3.2	3.2
	W	0.8	1.25	1.6	2.5
A		0.8 to 1.0	1.0 to 1.4	1.8 to 2.5	1.8 to 2.5
B		0.5 to 0.8	0.8 to 1.5	0.8 to 1.7	0.8 to 1.7
C		0.6 to 0.8	0.9 to 1.2	1.2 to 1.6	1.8 to 2.5



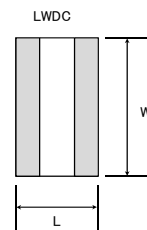
Reflow-soldering

Type		021	042	063	105	107	212	316	325	432
Size	L	0.25	0.4	0.6	1.0	1.6	2.0	3.2	3.2	4.5
	W	0.125	0.2	0.3	0.5	0.8	1.25	1.6	2.5	3.2
A		0.095~0.135	0.15~0.25	0.20~0.30	0.45~0.55	0.8~1.0	0.8~1.2	1.8~2.5	1.8~2.5	2.5~3.5
B		0.085~0.125	0.15~0.20	0.20~0.30	0.40~0.50	0.6~0.8	0.8~1.2	1.0~1.5	1.0~1.5	1.5~1.8
C		0.110~0.150	0.15~0.30	0.25~0.40	0.45~0.55	0.6~0.8	0.9~1.6	1.2~2.0	1.8~3.2	2.3~3.5

Note: Recommended land size might be different according to the allowance of the size of the product.

● LWDC: Recommended land dimensions for reflow-soldering (unit: mm)

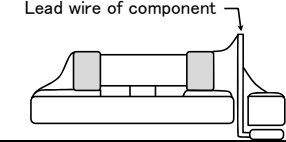
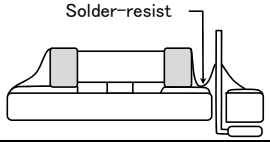
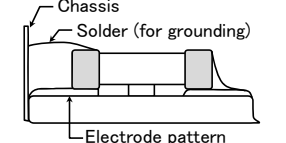
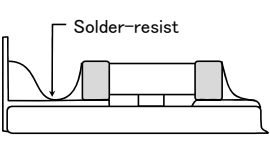
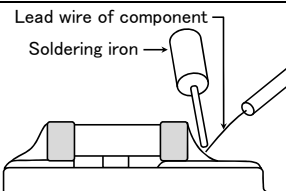
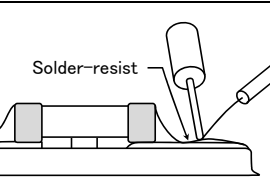
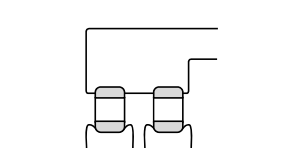
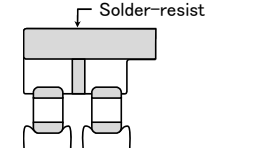
Type		105	107	212
Size	L	0.52	0.8	1.25
	W	1.0	1.6	2.0
A		0.18~0.22	0.25~0.3	0.5~0.7
B		0.2~0.25	0.3~0.4	0.4~0.5
C		0.9~1.1	1.5~1.7	1.9~2.1



Technical considerations

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(2) Examples of good and bad solder application

Item	Not recommended	Recommended
Mixed mounting of SMD and leaded components		
Component placement close to the chassis		
Hand-soldering of leaded components near mounted components		
Horizontal component placement		

◆ Pattern configurations (Capacitor layout on PCBs)

1-1. The following is examples of good and bad capacitor layouts ; capacitors shall be located to minimize any possible mechanical stresses from board warp or deflection.

Items	Not recommended	Recommended
Deflection of board		 Place the product at a right angle to the direction of the anticipated mechanical stress.

1-2. The amount of mechanical stresses given will vary depending on capacitor layout. Please refer to diagram below.



1-3. When PCB is split, the amount of mechanical stress on the capacitors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, please consider the PCB, split methods as well as chip location.

3. Mounting

Precautions

◆ Adjustment of mounting machine

- When capacitors are mounted on PCB, excessive impact load shall not be imposed on them.
- Maintenance and inspection of mounting machines shall be conducted periodically.

◆ Selection of Adhesives

- When chips are attached on PCBs with adhesives prior to soldering, it may cause capacitor characteristics degradation unless the following factors are appropriately checked : size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, please contact us for further information.

◆Adjustment of mounting machine

1. When the bottom dead center of a pick-up nozzle is too low, excessive force is imposed on capacitors and causes damages. To avoid this, the following points shall be considerable.
 - (1) The bottom dead center of the pick-up nozzle shall be adjusted to the surface level of PCB without the board deflection.
 - (2) The pressure of nozzle shall be adjusted between 1 and 3 N static loads.
 - (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins shall be used on the other side of the PCB. The following diagrams show some typical examples of good and bad pick-up nozzle placement:

Item	Improper method	Proper method
Single-sided mounting		
Double-sided mounting		

Technical considerations

2. As the alignment pin is worn out, adjustment of the nozzle height can cause chipping or cracking of capacitors because of mechanical impact on the capacitors. To avoid this, the monitoring of the width between the alignment pins in the stopped position, maintenance, check and replacement of the pin shall be conducted periodically.

◆Selection of Adhesives

Some adhesives may cause IR deterioration. The different shrinkage percentage of between the adhesive and the capacitors may result in stresses on the capacitors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect components. Therefore, the following precautions shall be noted in the application of adhesives.

- (1) Required adhesive characteristics
 - a. The adhesive shall be strong enough to hold parts on the board during the mounting & solder process.
 - b. The adhesive shall have sufficient strength at high temperatures.
 - c. The adhesive shall have good coating and thickness consistency.
 - d. The adhesive shall be used during its prescribed shelf life.
 - e. The adhesive shall harden rapidly.
 - f. The adhesive shall have corrosion resistance.
 - g. The adhesive shall have excellent insulation characteristics.
 - h. The adhesive shall have no emission of toxic gasses and no effect on the human body.
- (2) The recommended amount of adhesives is as follows;

[Recommended condition]

Figure	212/316 case sizes as examples
a	0.3mm min
b	100 to 120 μm
c	Adhesives shall not contact land



4. Soldering

◆Selection of Flux

- Since flux may have a significant effect on the performance of capacitors, it is necessary to verify the following conditions prior to use;
- (1) Flux used shall be less than or equal to 0.1 wt% (in Cl equivalent) of halogenated content. Flux having a strong acidity content shall not be applied.
 - (2) When shall capacitors are soldered on boards, the amount of flux applied shall be controlled at the optimum level.
 - (3) When water-soluble flux is used, special care shall be taken to properly clean the boards.

Precautions

◆Soldering

Temperature, time, amount of solder, etc. shall be set in accordance with their recommended conditions.
Sn-Zn solder paste can adversely affect MLOC reliability.
Please contact us prior to usage of Sn-Zn solder.

Technical considerations

◆Selection of Flux

- 1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate flux, or highly acidic flux is used, it may lead to corrosion of terminal electrodes or degradation of insulation resistance on the surfaces of the capacitors.
- 1-2. Flux is used to increase solderability in wave soldering. However if too much flux is applied, a large amount of flux gas may be emitted and may adversely affect the solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.
- 1-3. Since the residue of water-soluble flux is easily dissolved in moisture in the air, the residues on the surfaces of capacitors in high humidity conditions may cause a degradation of insulation resistance and reliability of the capacitors. Therefore, the cleaning methods and the capability of the machines used shall also be considered carefully when water-soluble flux is used.

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◆ Soldering

- Ceramic chip capacitors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling.
- Therefore, the soldering must be conducted with great care so as to prevent malfunction of the components due to excessive thermal shock.
- Preheating : Capacitors shall be preheated sufficiently, and the temperature difference between the capacitors and solder shall be within 130°C.
- Cooling : The temperature difference between the capacitors and cleaning process shall not be greater than 100°C.

[Reflow soldering]

【Recommended conditions for eutectic soldering】



【Recommended condition for Pb-free soldering】



Caution

- ① The ideal condition is to have solder mass (fillet) controlled to 1/2 to 1/3 of the thickness of a capacitor.
- ② Because excessive dwell times can adversely affect solderability, soldering duration shall be kept as close to recommended times as possible. soldering for 2 times.



[Wave soldering]

【Recommended conditions for eutectic soldering】



【Recommended condition for Pb-free soldering】



Caution

- ① Wave soldering must not be applied to capacitors designated as for reflow soldering only. soldering for 1 times.

[Hand soldering]

【Recommended conditions for eutectic soldering】



【Recommended condition for Pb-free soldering】



316type or less	$\Delta T \leq 150^{\circ}\text{C}$
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325type or more	$\Delta T \leq 130^{\circ}\text{C}$
-----------------	-------------------------------------

Caution

- ① Use a 50W soldering iron with a maximum tip diameter of 1.0 mm.
- ② The soldering iron shall not directly touch capacitors. soldering for 1 times.

5. Cleaning	
Precautions	<p>◆Cleaning conditions</p> <ol style="list-style-type: none"> When PCBs are cleaned after capacitors mounting, please select the appropriate cleaning solution in accordance with the intended use of the cleaning. (e.g. to remove soldering flux or other materials from the production process.) Cleaning condition shall be determined after it is verified by using actual cleaning machine that the cleaning process does not affect capacitor's characteristics.
Technical considerations	<ol style="list-style-type: none"> The use of inappropriate cleaning solutions can cause foreign substances such as flux residue to adhere to capacitors or deteriorate their outer coating, resulting in a degradation of the capacitor's electrical properties (especially insulation resistance). Inappropriate cleaning conditions (insufficient or excessive cleaning) may adversely affect the performance of the capacitors. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of PCBs which may lead to the cracking of capacitors or the soldered portion, or decrease the terminal electrodes' strength. Therefore, the following conditions shall be carefully checked; Ultrasonic output : 20 W/l or less Ultrasonic frequency : 40 kHz or less Ultrasonic washing period : 5 min. or less

6. Resin coating and mold	
Precautions	<ol style="list-style-type: none"> With some type of resins, decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the capacitor's performance. When a resin's hardening temperature is higher than capacitor's operating temperature, the stresses generated by the excessive heat may lead to damage or destruction of capacitors. The use of such resins, molding materials etc. is not recommended.

7. Handling	
Precautions	<p>◆Splitting of PCB</p> <ol style="list-style-type: none"> When PCBs are split after components mounting, care shall be taken so as not to give any stresses of deflection or twisting to the board. Board separation shall not be done manually, but by using the appropriate devices. <p>◆Mechanical considerations</p> <p>Be careful not to subject capacitors to excessive mechanical shocks.</p> <p>(1) If ceramic capacitors are dropped onto a floor or a hard surface, they shall not be used.</p> <p>(2) Please be careful that the mounted components do not come in contact with or bump against other boards or components.</p>

8. Storage conditions	
Precautions	<p>◆Storage</p> <ol style="list-style-type: none"> To maintain the solderability of terminal electrodes and to keep packaging materials in good condition, care must be taken to control temperature and humidity in the storage area. Humidity should especially be kept as low as possible. <ul style="list-style-type: none"> Recommended conditions Ambient temperature : Below 30°C Humidity : Below 70% RH The ambient temperature must be kept below 40°C. Even under ideal storage conditions, solderability of capacitor is deteriorated as time passes, so capacitors shall be used within 6 months from the time of delivery. <ul style="list-style-type: none"> Ceramic chip capacitors shall be kept where no chlorine or sulfur exists in the air. The capacitance values of high dielectric constant capacitors will gradually decrease with the passage of time, so care shall be taken to design circuits. Even if capacitance value decreases as time passes, it will get back to the initial value by a heat treatment at 150°C for 1 hour.
Technical considerations	<p>If capacitors are stored in a high temperature and humidity environment, it might rapidly cause poor solderability due to terminal oxidation and quality loss of taping/packaging materials. For this reason, capacitors shall be used within 6 months from the time of delivery. If exceeding the above period, please check solderability before using the capacitors.</p>

※RCR-2335B (Safety Application Guide for fixed ceramic capacitors for use in electronic equipment) is published by JEITA.

Please check the guide regarding precautions for deflection test, soldering by spot heat, and so on.